

VHF FM Transceiver **VX-6000V** Service Manual

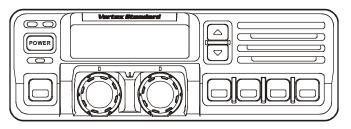
Vertex Standard LMR, Inc.

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Introduction

This manual provides technical information necessary for servicing the VX-6000V VHF FM Transceiver.

Servicing this equipment requires expertise in handling surface-mount chip components. Attempts by non-qualified persons to service this equipment may result in permanent damage not covered by the warranty, and may be illegal in some countries.



Two PCB layout diagrams are provided for each double-sided circuit board in the Transceiver. Each side of is referred to by the type of the majority of components installed on that side ("leaded" or "chip-only"). In most cases one side has only chip components, and the other has either a mixture of both chip and leaded components (trimmers, coils, electrolytic capacitors, ICs, etc.), or leaded components only.

While we believe the technical information in this manual to be correct, VERTEX STANDARD assumes no liability for damage that may occur as a result of typographical or other errors that may be present. Your cooperation in pointing out any inconsistencies in the technical information would be appreciated.

Important Note

After Lot. 22 of this transceiver is assembled using Pb (lead) free solder, based on the RoHS specification. Only lead-free solder (Alloy Composition: Sn-3.0Ag-0.5Cu) should be used for repairs performed on this apparatus. The solder stated above utilizes the alloy composition required for compliance with the lead-free specification, and any solder with the above alloy composition may be used.

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Specifications

General	
Frequency Range:	148 - 174 MHz
Number of Channels:	250 channels
Channel Spacing:	12.5 / 25 kHz
Power Supply Voltage:	13.4V DC ±15 %
Current Consumption:	Standby: 600 mA
	Receive: 2.2 A
	Transmit: 28 A (High)
Ambient Temperature Range:	–22 °F to +140 °F (–30 °C to +60 °C)
Frequency Stability:	Better than ±2 ppm
RF Input-Output Impedance :	50 Ohms
Audio Output Impedance:	4 Ohms
Dimensions:	7" (w) x 2.4" (H)x 11.9" (D) (178 x 60 x 301 mm)
Weight (Approx.):	15.4 lbs. (7.0 kg)

RECEIVER (Measurements made per EIA standard TIA/EIA-603)

Circuit Type:	Double-conversion Super-heterodyne
Sensitivity (EIA 12 dB SINAD):	0.25 μV
Adjacent Channel Selectivity:	85/80 dB
Intermodulation:	80/75 dB
Spurious and Image Rejection:	90 dB
Audio Output:	5 W @ 4 Ohms w/3 % THD
	10 W @ 4 Ohms w/3 % THD (Optional MLS-100)

TRANSMITTER (Measurements made per EIA standard TIA/EIA-603)

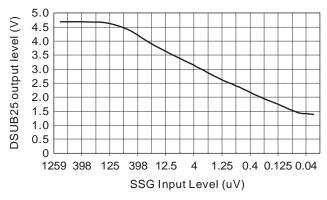
Power Output:	110 / 50 W
Modulation:	16K0F3E, 11K0F3E
Max Deviation:	5.0/2.5 kHz
Conducted Spurious Emissions :	80 dB Below Carrier
Audio Distortion (@ 1 kHz):	< 2 %

Measurements per EIA standards unless noted above. Specifications subject to change without notice or obligation.

DSUB 25-Pin Accessory Connector

Pin 1: RSSI [Analog Output]

A DC voltage proportional to the strength of the signal currently being received (Receiver Signal Strength Indicator) is provided on this pin. This low impedance output is generated by the receiver IF sub-system and buffered by an internal opamp. Typical voltages are graphed as follows:

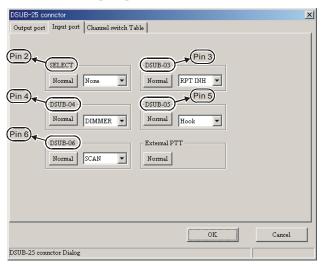


Pin 2, 3, 4, 5 & 6: SELECT, DSUB 03, DSUB 04, DSUB 05 & DSUB 06

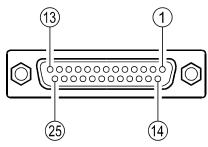
[Digital Input Port]

These input port features can be programmed via the CE49 programmer. The same item can not be chosen twice.

To select the "Input port" page, (Common 🗰 DSUB-25 Imput port).



LOGIC level (+5V / 0V) input (Low active). High Impedance input.



DSUB 25-Pin Numbering

None MON This feature is the same as pressing and holding in the Monitor key. DIMMER LCD illumination dimmer "on." Hook Activates the Hook1 feature. SCAN Activates the scanner. G-SCAN Activates the Group scanner. **RPT INH** Disables the repeater feature during Multi Deck operation. Activates the Emergency feature. EMG Switches to the Home Channel. Home CH SW0 Memory channel recall (Channel Switch Table bit 0) CH SW1 Memory channel recall (Channel Switch Table bit 1) CH SW2 Memory channel recall (Channel Switch Table bit 2) CH SW3 Memory channel recall (Channel Switch Table bit 3) Example

If you assign "CH SW0" and "CH SW1" to the Universal Input Port, you can recall Channels 1~3 as shown below.

Ch	anr	nel	CH SW0	CH SW1
	1		1	0
	2		0	1
	3	,	1	1

DSUB-	5 connetor			×
Outp	port Input port	Channel switch Table		
	Group tag	Channel tag	Group tag	Channel tag
1	GROUP001 💌	Ch001:CHAN-001 -	9 None 💌	None
2	GROUP001 💌	None	10(<u>A</u>) None 💌	None
2	None	None	11(B) None 💌	None
4	None	None	12(C) None 💌	None
<u>5</u>	None	None	13(D) None 💌	None
<u>6</u>	None	None	14(E) None 💌	None
2	None 💌	None	15(F) None 💌	None
8	None	None		
			OK	Cancel
Group t	ag select			<select></select>

DSUB 25-Pin Accessory Connector

Similarly, if you assign "CH SW0," "CH SW1," and "CH SW2" to the Universal Input Port, you can recall Channels 1~7 as shown below:

Channel	CH SW0	CH SW1	CH SW2
1	1	0	0
2	0	1	0
3	1	1	0
4	0	0	1
5	1	0	1
6	0	1	1
7	1	1	1

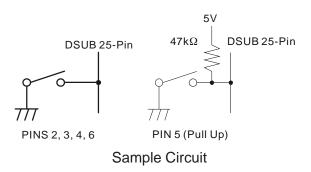
If you need to recall all memory channels (15 CH) from the External Controller via the Uni-versal Input Port, you should assign the "All Channel Recall" Command (CH SW 0 ~ CH SW 3) to the Universal Input Port.

In this case:

Channel	CH SW0	CH SW1	CH SW2	CH SW3
1	1	0	0	0
2	0	1	0	0
3	1	1	0	0
4	0	0	1	0
5	1	0	1	0
6	0	1	1	0
7	1	1	1	0
8	0	0	0	1
9	1	0	0	1
10	0	1	0	1
11	1	1	0	1
12	0	0	1	1
13	1	0	1	1
14	0	1	1	1
15	1	1	1	1

The Memory Channel is determined via the CE49 Programmer. (Common **DSUB-25pin connector** tor **Channel switch Table**).

DSUB-25 connet	or				X
Output port Inp	out port Channel swit	ch Table			
Group	tag Channe	el tag	Group tag	Channel tag	
1 GROUP00	01 Ch001:CHAP	4-001 💌 <u>9</u>	None 💌	None	•
2 GROUP00)1 Vone	▼ 10(<u>A</u>)	None	None	•
3 None	• None	▼ 11(<u>B</u>)	None	None	•
4 None	• None	▼ 12(<u>C</u>)	None	None	•
5 None	• None	▼ 13(D)	None	None	•
6 None	• None	▼ 14(<u>E</u>)	None	None	•
<u>7</u> None	• None	▼ 15(F)	None	None	•
8 None	• None	•			
			OK	Cance	1
Group tag select				<select></select>	
1				,	



Pin 7: E [GND]

Ground for all logic levels and power supply return.

Pin 8: A KEY OUT [Universal Output Port]

Open collector output. Output voltage 0 ~ 5 V, Max. sink current 30 mA.

The possible programming features (use CE49) are illustrated below.

A PORT/B PORT/C PORT/D PORT/E PORT/ None

Refer to the "Pins 20, 21, & 22" section for details.

Pin 9: TXD [Digital Output for Alignment software]

Connect to the RS232C cable (requires FIF-8 and CT-88)

Pin 10: RXD [Digital Input for Alignment software] Connect to the RS232C cable (requires FIF-8 and CT-88)

Pin 11: EXT PTT

Shorting this port to ground causes the transceiver to be placed in the Transmit mode, while opening the connection to this port returns the transceiver to the Receive mode.

Pin 12: MIC MUTE

MIC mute on: Level High (5V) MIC mute off: Open LOGIC level (+5V / 0V) output. When the PTT/EXT PTT switch is pressed, this pin switches to "open."

DSUB 25-Pin Accessory Connector

Pin 13: TXDI [Digital Input for DATA Communications]

- O TX Hi-speed Data Input Type (jumper JP2005). Input level 800 mV/600 Ohms, Max.input 1.2V
- O Tx Low-speed Data input Type (Jumper JP2006). Input level 40 mV/600-Ohms

If the Jumper setting is "Low-speed Data" (JP2006 jumpered), this port is usable in the AUDIO (300~3000 Hz) range.

If the jumper setting is "HI-speed Data" (JP2005 jumpered), this port is usable for 9600 bps DATA communications, because the filter and limiter are not engaged in the Audio line.

Pin 14: DC OUT [13.4 V/5 V DC Output]

- O Switched 13.8V output for supplying power to an accessory (jumper JP2008).
- O Switched and regulated DC 5.0V output for supplying power to an accessory (jumper JP2007).

Maximum output current is 200 mA

Pin 15: IGN [Ignition Sense feature]

Connecting this line to the ignition sense line of the vehicle will automatically turn the radio on when the vehicle's ignition key is turned on.

Pin 16: NC [NO connection]

Pin 17: RX DO [Digital Output for DATA Communications]

- O RX Hi-speed Data Output Type (jumper JP2003). output level 600 mV/10k Ohms
- O RX Low-speed Data Output Type (jumper JP2004). output level 200 mV/600 Ohms

If the Jumper setting is "Low-speed Data" (JP2004 jumpered), this port is usable in the AUDIO (300~3000 Hz) range.

If the jumper setting is "HI-speed Data" (JP2003 jumpered), this port is usable for 9600 bps DATA communications, because the filter and limiter are not engaged in the Audio line.

Pin 18: E [GND]

Ground for all logic levels and power supply return.

Pins 19, 20, 21, & 22: DSUB 19, DSUB 20, DSUB 21 and DSUB 22

[Universal Output Port]

LOGIC level (+5V / 0V) output.

The logic output appears at these pins when the front panel's PF key is turned on.

The possible programming features (use CE49) are illustrated below.

If the HA feature is assigned to these ports, a current amplifier must be connected between the Horn circuit and the port.

None/A PORT/B PORT/C PORT/D PORT/E PORT/HA PORT

Pin 23: EXT SQL [Squelch Signal Output]

Open collector output. Max. sink current 10 mA. A Signal is present (Squelch is open): Level High No Signal is present (Squelch is closed): Open When you connect the solder jumper on J2002, this port changes to PULL UP (5 V) output. This status can be changed by CE49 programmer.

Pin 24: SP MUTE [Speaker Mute Output]

Open collector output. External Speaker mute on: Level High External Speaker mute off: Open

Pin 25: E [GND]

Chassis ground.

Cloning

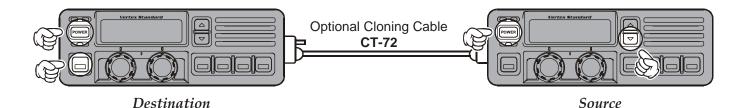
The **VX-6000** includes a convenient "Clone" feature, which allows the programming data from one transceiver to be transferred to another **VX-6000**. Here is the procedure for Cloning one radio's data to another.

Note: When a cloning isn't made, you correct the following part using "CE49."

When a "Radio to Radio Clone" which is in the "Miscellaneous" menu is "Disabled," change this menu to "Enabled."

- 1. Turn both transceivers off.
- Remove the plastic cap and its two mounting screws from the MIC/SP jack on the transceiver. Do this for both transceivers.
- 3. Connect the optional **CT-72** cloning cable between the **MIC/SP** jacks of the two transceivers.
- 4. On the *Destination* transceiver, press and hold the **PF Button** (just below the **POWER Button**) while turning the transceiver on.

- Now, on the *Source* transceiver, press and hold the ▼ Button while turning the transceiver on.Data will now be transferred to the *Destination* transceiver from the *Source* transceiver.
- If there is a problem during the cloning process, sound an error beep from source the transceiver. Check your cable connections and battery voltage, and try again.
- 7. If cloning is a successful, turn the *Destination* transceiver off. Now turn the *Source* transceiver off.
- 8. Disconnect the **CT-72**. Replace the plastic cap and its two mounting screws.
- 9. You can then turn the transceivers back on, and begin normal operation.



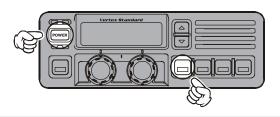
Dealer Programming of VTP-50 and F5D-14

These procedures are designed to be used by the installing technician after the **VTP-50** and **F5D-14** has been installed in the transceiver. To program a **VX-6000**'s **VTP-50** and **F5D-14** board, you will need the **CT-71** programming interface cable, the **CE26** Programming diskette, and an IBM PC/AT or PS/2-compatible type computer.

To enter the Programming mode, use the following procedure:

1. Turn the transceiver off.

Turn on the transceiver while holding in the **PF Button** (just below the **▼ Button**).



		Screw List	
REF.	VXSTD P/N	Description	Qty.
1	U20306007	BINDING HEAD SCREW M3x6B	7
2	U20306002	BINDING HEAD SCREW M3x6NI	6
(3)	U24308002	TAPTITE SCREW M3x8NI	17 (w/MIC CONN Unit)
9	024306002	TAPTITE SCREW WSXON	13 (w/MIC CONN-2 Unit)
4	U23206001	TAPTITE SCREW M2.6x6	14
5	U20305007	BINDING HEAD SCREW M3x5B	2
6	U32450007	FLAT HEAD SCREW M2.6x5B	2
7	U31306007	OVAL HEAD SCREW M3x6B	2
8	U20308002	BINDING HEAD SCREW M3x8NI	2
9	U02308002	SEMS SCREW SM3x8NI	4
10	U24208001	TAPTITE SCREW M2.6x8	1
(11)	S5000182	SCREW JFS-4S-B1MW	2
(12)	U04306002	SEMS SCREW HSM3x6NI	3

RA037890B PANELASSY

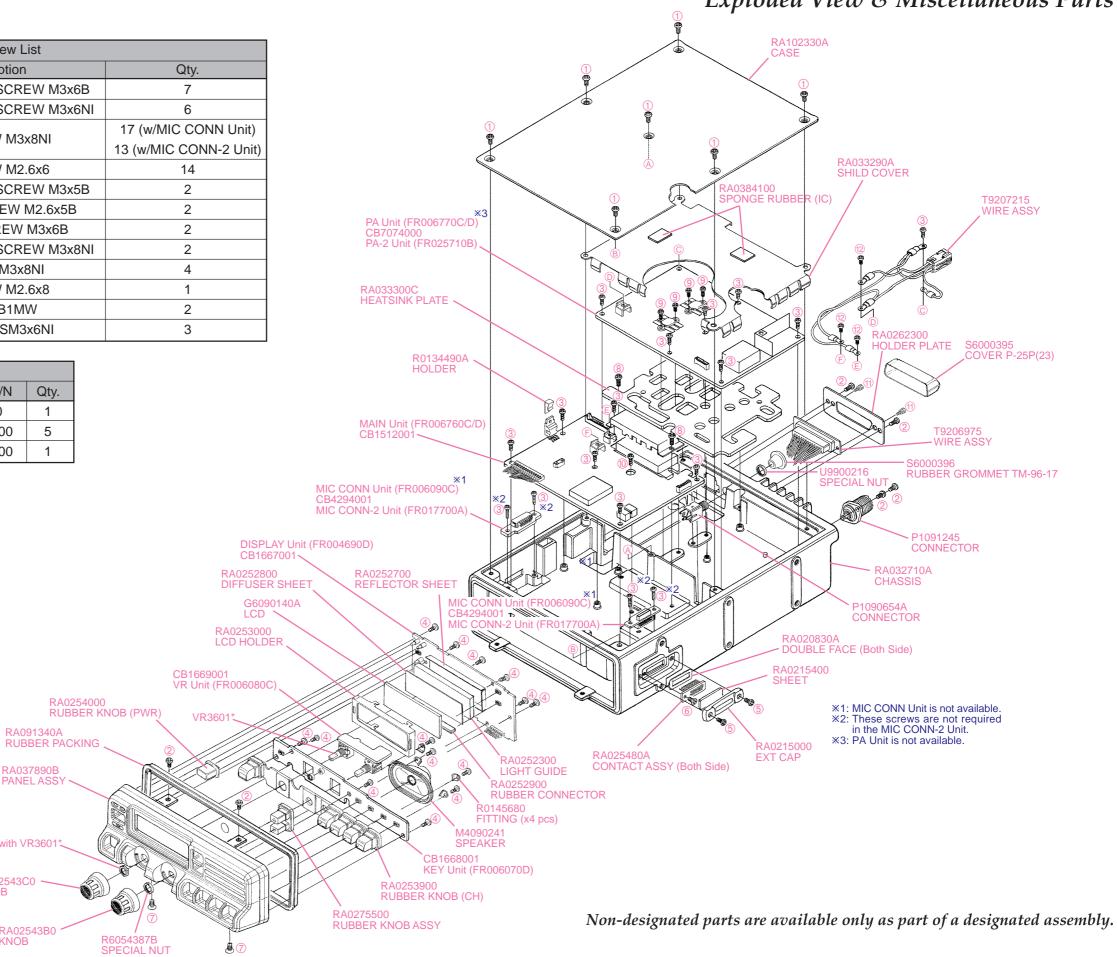
Supplied with VR3601*

RA02543C0 KNOB

RA02543B0 KNOB

87

Accessories		
Description	VXSTD P/N	Qty.
DC CABLE 04P 40AX2	T9023140	1
KNOB CAP	RA0254100	5
NAME PLATE	RA0254700	1



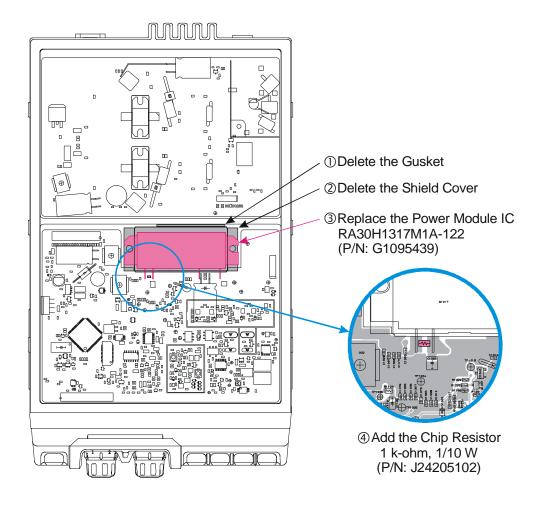
Exploded View & Miscellaneous Parts

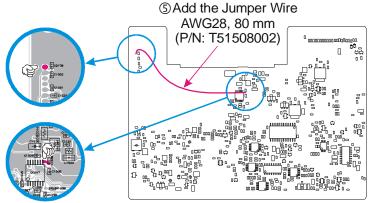
MAIN Unit Modifications

The PA Unit have been discontinued. Therefore, the PA Unit is not possible to order as the repair parts, and replaced with the PA-2 Unit.

When replacing the PA Unit to PA-2 Unit, you must be modified the MAIN Unit as following.

- ① Delete the Gusket (RA0530900). This part is no longer needed.
- ② Delete the Shield Cover (RA0124501). This part is no longer needed.
- ③ Replace the Power Module IC (G1094314 \rightarrow G1095439: RA30H1317M1A-122).
- ④ Add the Chip Resistor (J24205102) between Pin 1 and Pin 2 of Q1017 (Power Module IC).
- (5) Add the Jumper wire (T51508002) between the Pin 8 of J1001 and Pin 8 of Q1007.



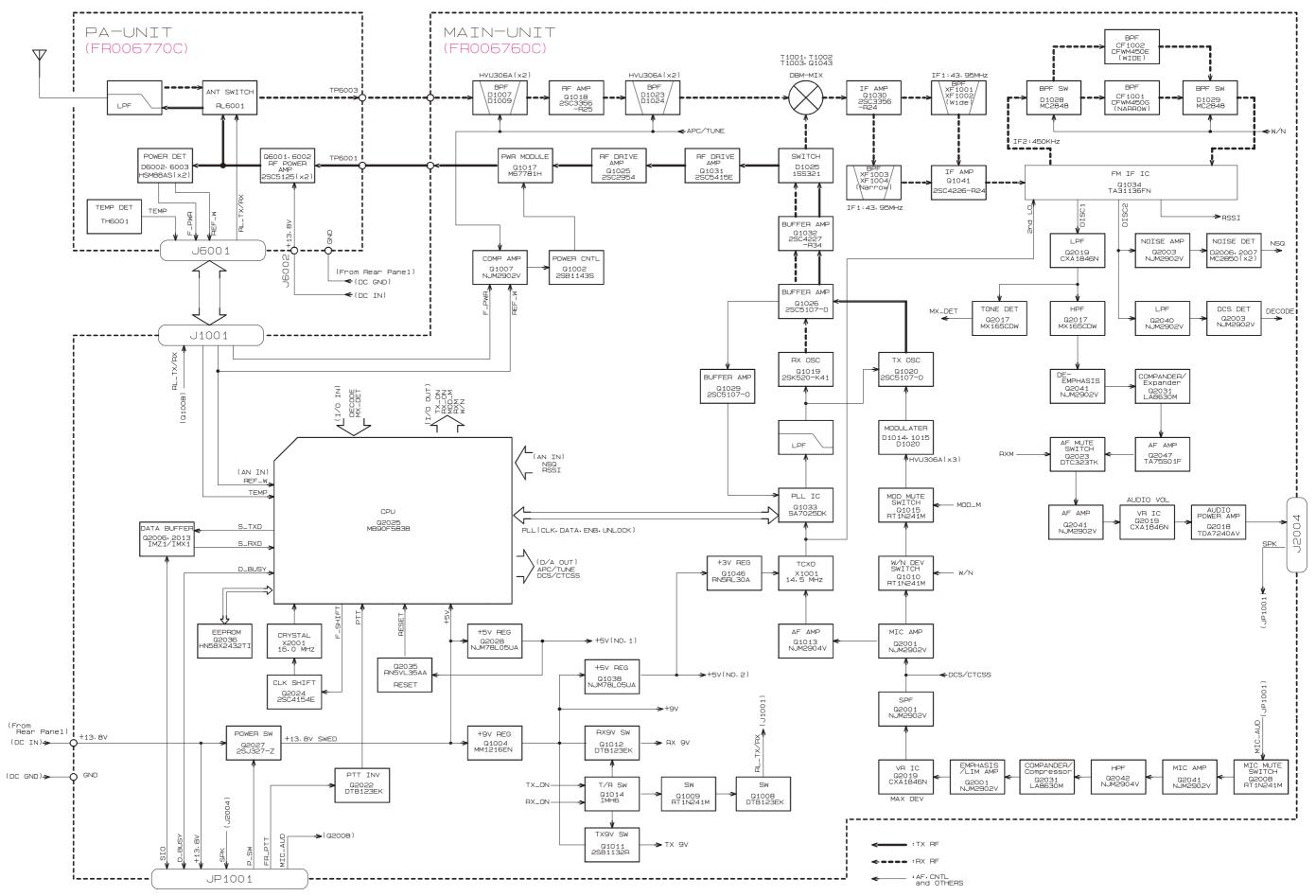


Parts List

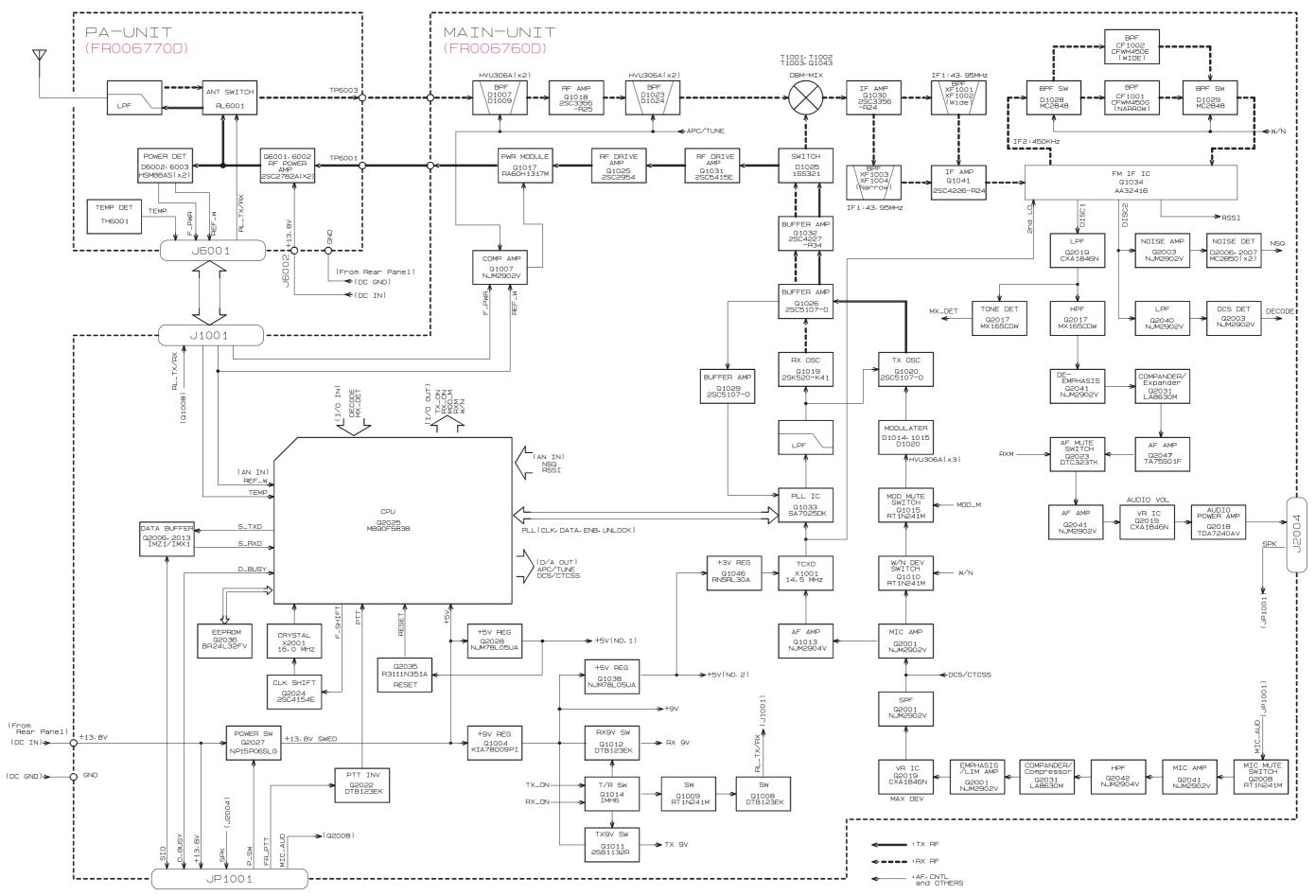
REF.	DESCRIPTION	VALUE	V/W T	DL. MFR'S DESIG	VXSTD P/N	VERS.	LOT.	SIDE	LAY ADR
			Printed	Circuit Board with Components	4				
	MAIN Unit				CB1512001				
L	DISPLAY Unit	CB1667001							
	KEY Unit	CB1668001							
	VR Unit MIC CONN-2 Unit	CB1669001 CB4294001							
	PA-2 Unit				CB4294001 CB7074000				
					CB7074000				
	1			Mechanical Parts	1		1		
	PANEL ASSY				RA037890B				
	CHASSIS				RA032710A				
	CASE RUBBER PACKING				RA102330A RA091340A				
	VOL KNOB				RA02543C0				
	CHANNEL KNOB				RA02543B0				
	RUBBER KNOB			(PWR)	RA0254000				
	RUBBER KNOB			(CH)	RA0253900				
	RUBBER KNOB ASSY				RA0275500				
	SPECIAL NUT			(CH)	R6054387B				
	LCD HOLDER				RA0253000				
	LIGHT GUIDE				RA0252300				
	REFLECTOR SHEET				RA0252700				
	RUBBER CONNECTOR				RA0252900				
	DIFFUSER SHEET SEMS SCREW	3 000		HSM3x6NI	RA0252800				
	BINDING HEAD SCREW	3 pcs 2 pcs		M3x5B	U20305007				
	BINDING HEAD SCREW	6 pcs		M3x6NI	U20306002				
	BINDING HEAD SCREW	7 pcs		M3x6B	U20306007				
	SEMS SCREW	4 pcs		SM3x8NI	U02308002				
	BINDING HEAD SCREW	2 pcs		SM3x8NI	U20308002				
	TAPTITE SCREW	14 pcs		M2.6x6	U23206001				
	TAPTITE SCREW	1 pc		M2.6x8	U24208001				
	TAPTITE SCREW	17 or 13 pcs		M3x8NI	U24308002				
	OVAL HEAD SCREW	2 pcs		M3x6B	U31306007				
	FLAT HEAD SCREW SCREW	2 pcs 2 pcs		M2.6x5B JFS-4S-B1WM	U32450007 S5000182				
			· · · · · ·		,				
		4 5 14/2 0		Electrical Parts	M4000044		1		
L	SPEAKER CONNECTOR	1.5 W/8 Ω		A-S0005030-002 MR-S	M4090241 P1091245				
	CONNECTOR			MR-3	P1091245				
			Ν	AIN Unit Electrical Parts					
	CERAMIC DISC			CDBCB450KCAY24-R0	H7901340		1-	В	a4
	CERAMIC FILTER			CFWLB450KGFA-B0	H3900435		1-	A	G5
	CERAMIC FILTER	4 5 41 1		CFWLB450KE2A-B0	H3900466		1-	A	G5
	CERAMIC OSC CHIP FUSE	1MHz		CSBFB1M00J2B021-R1	H7900950		1-	A	B3
F 2001 Q 1017		0.25A		KAB2402-251NA31010 RA60H1317M-124	Q0000085 G1094314	For PA Unit	1-	A	B1 E1
Q 1017				RA30H1317M1A-122	G1094314 G1095439	For PA-2 Unit		Â	E1
	TRANSISTOR			A7240L-TB7-T	G1095431		1-	A	A3
-	TRIMMER CAP.	10pF		TZB4Z100AA10R00	K91000285		1-	A	E5
	TRIMMER CAP.	20pF		TZB4R200AA10R00	K91000217		1-	Α	D4
	THERMISTOR			TBPS1R103K440H5Q	G9090067		1-	A	G4
	THERMISTOR			TBPS1R103K440H5Q	G9090067		1-	A	G4
VR1001				EVM3YSX50BC5	J51833154		1-	A	F5
X 1001	XTAL OSC	14.5MHz 16MHz		TTS12V 14.5MHZ	H9500630		1-	A	F5
X 2001	XTAL 92SMX(CN) XTAL FILTER	16MHz 43.95MHz		16.000MHZ UM-5-3P 43Y12B5F	H0103322 H1102425		1-	A	A4 F4
	XTAL FILTER	43.95MHz		UM-5-3P 43Y12B5F	H1102425		1-	A	F4 F4
	XTAL FILTER	43.95MHz		43Y07B5 UM-5-3P	H1102425		1-	Â	F4
	XTAL FILTER	43.95MHz		43Y07B5 UM-5-3P	H1102486		1-	A	F4
				-					

Parts List

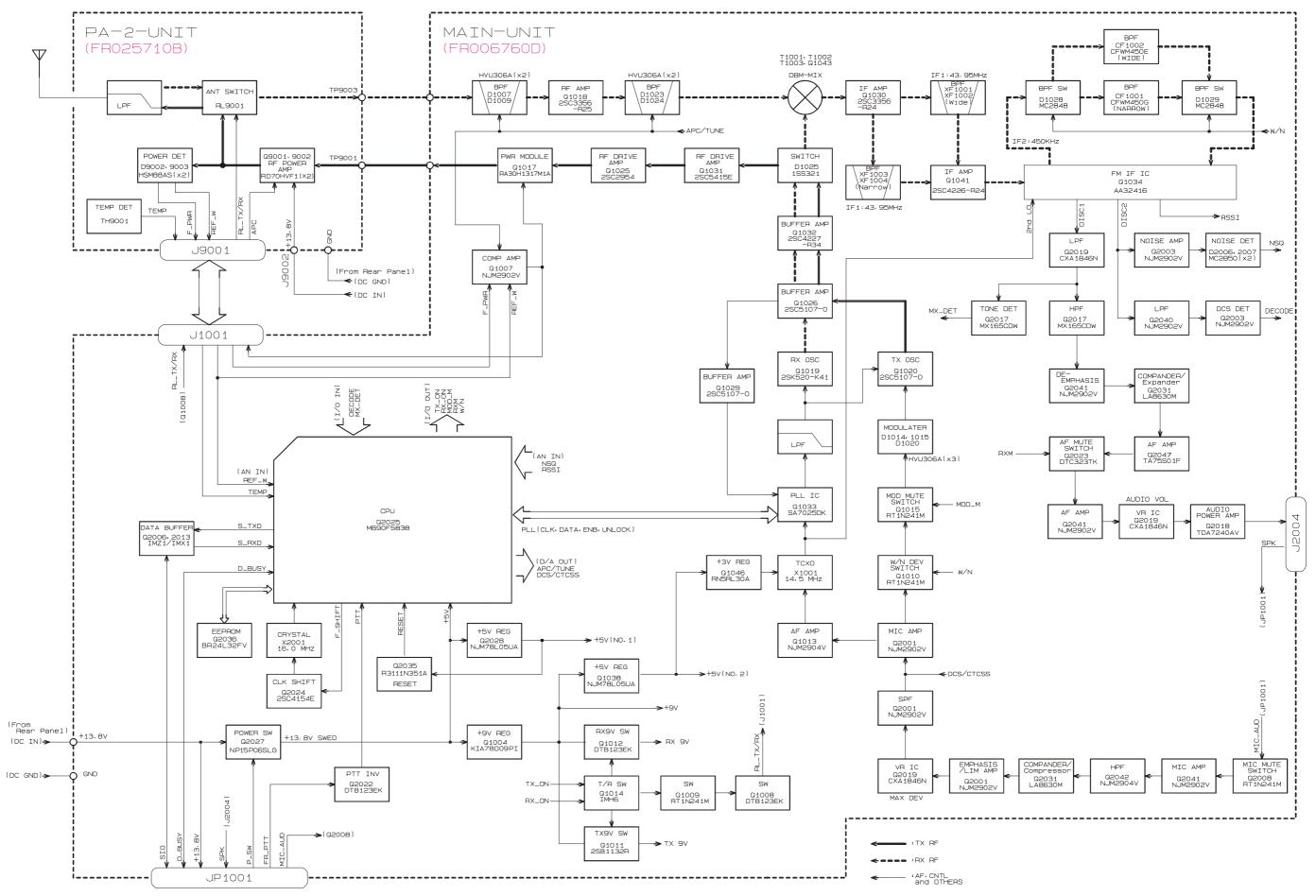
REF.	DESCRIPTION	VALUE	V/W	TOL.	MFR'S DESIG	VXSTD P/N	VERS.	LOT.	SIDE	LAY ADR	
	I				AY Unit Electrical Parts						
DS3002	LCD				M762-1	G6090140A		1-	A	D1	
	TACT SWITCH				SKQDAB	N5090058		1-	A	A1	
	TACT SWITCH				SKQDAB	N5090058		1-	A	F1	
	TACT SWITCH				SKQDAB	N5090058		1-	A	F1	
	XTAL 92SMX(CN)	16MHz			16.000MHZ	H0103322		1-	B	a3	
10001		1011112		1		THOTOGOLL		<u> </u>		40	
		1	1	KEY	Unit Electrical Parts			1			
	MIC. ELEMENT				EM240T	M3290066		1-	A		
S 3401	TACT SWITCH				SKQDAB	N5090058		1-	A		
	TACT SWITCH				SKQDAB	N5090058		1-	A		
S 3403	TACT SWITCH				SKQDAB	N5090058		1-	A		
S 3404	TACT SWITCH				SKQDAB	N5090058		1-	A		
S 3405	TACT SWITCH				SKQDAB	N5090058		1-	A		
					Unit Electrical Parts						
S 3601	VR Unit Electrical Parts S 3601 ROTARY SWITCH SRZW0L010K N0190177 1- A										
VR3601					RK09L1120 L=15 10KC	J60800258		1-	A		
					•	· ·					
0.000	CCT.	1	1	PA-2	2 Unit Electrical Parts					62	
	FET				RD70HVF1-101	G3090140		201-	A	C2	
Q 9002					RD70HVF1-101	G3090140		201-	A	C3	
RL9001			DC9V		G6Z-1PE-A DC9V	M1190220		201-	A	E3	
	THERMISTOR				NTCG164LH104JT1	G9090192		201-	A	C3	
TH9002	THERMISTOR				NTCG164BH102JT1	G9090188		201-	A	D4	



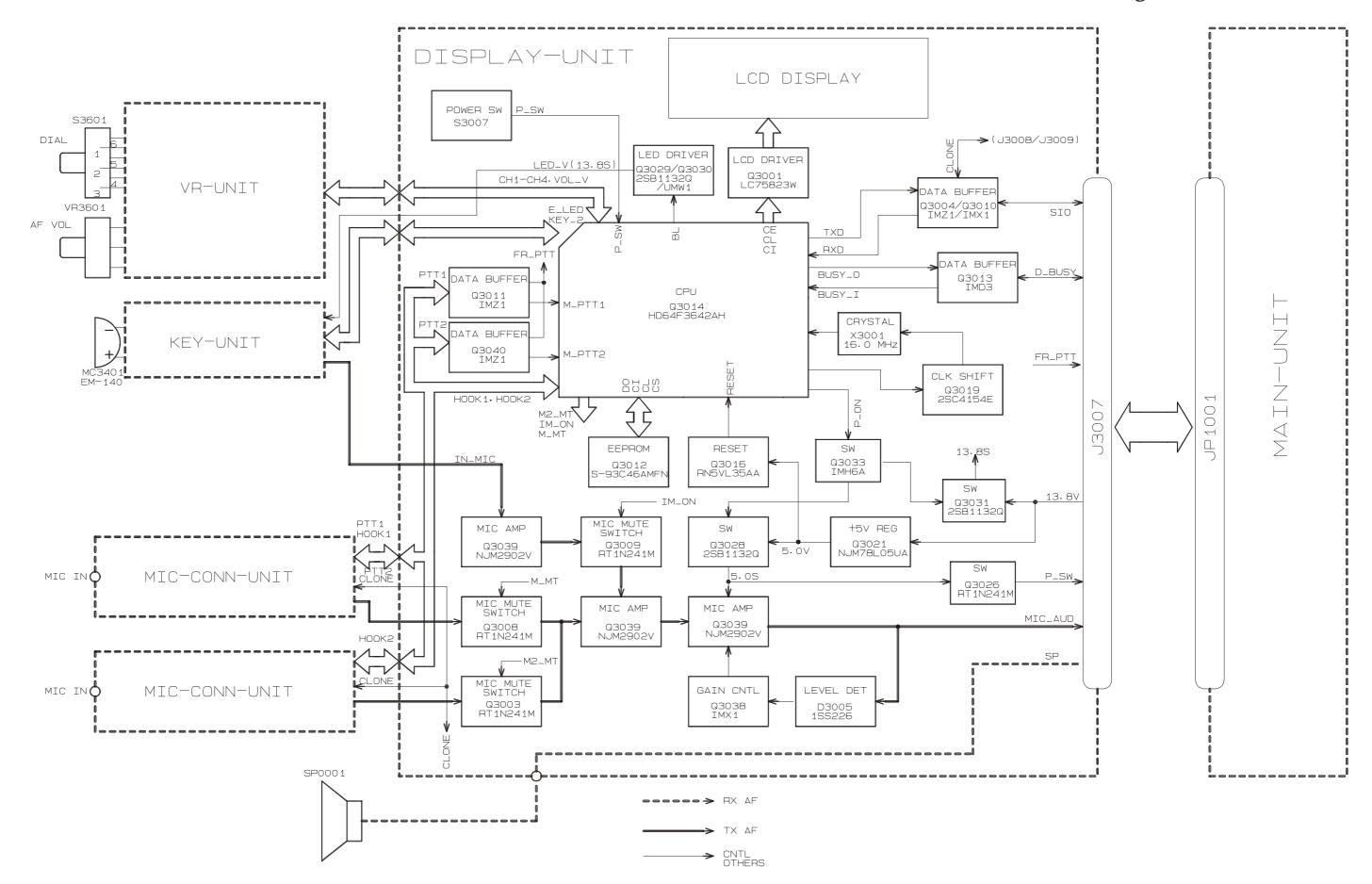
Block Diagram: MAIN Unit & PA Unit (1)



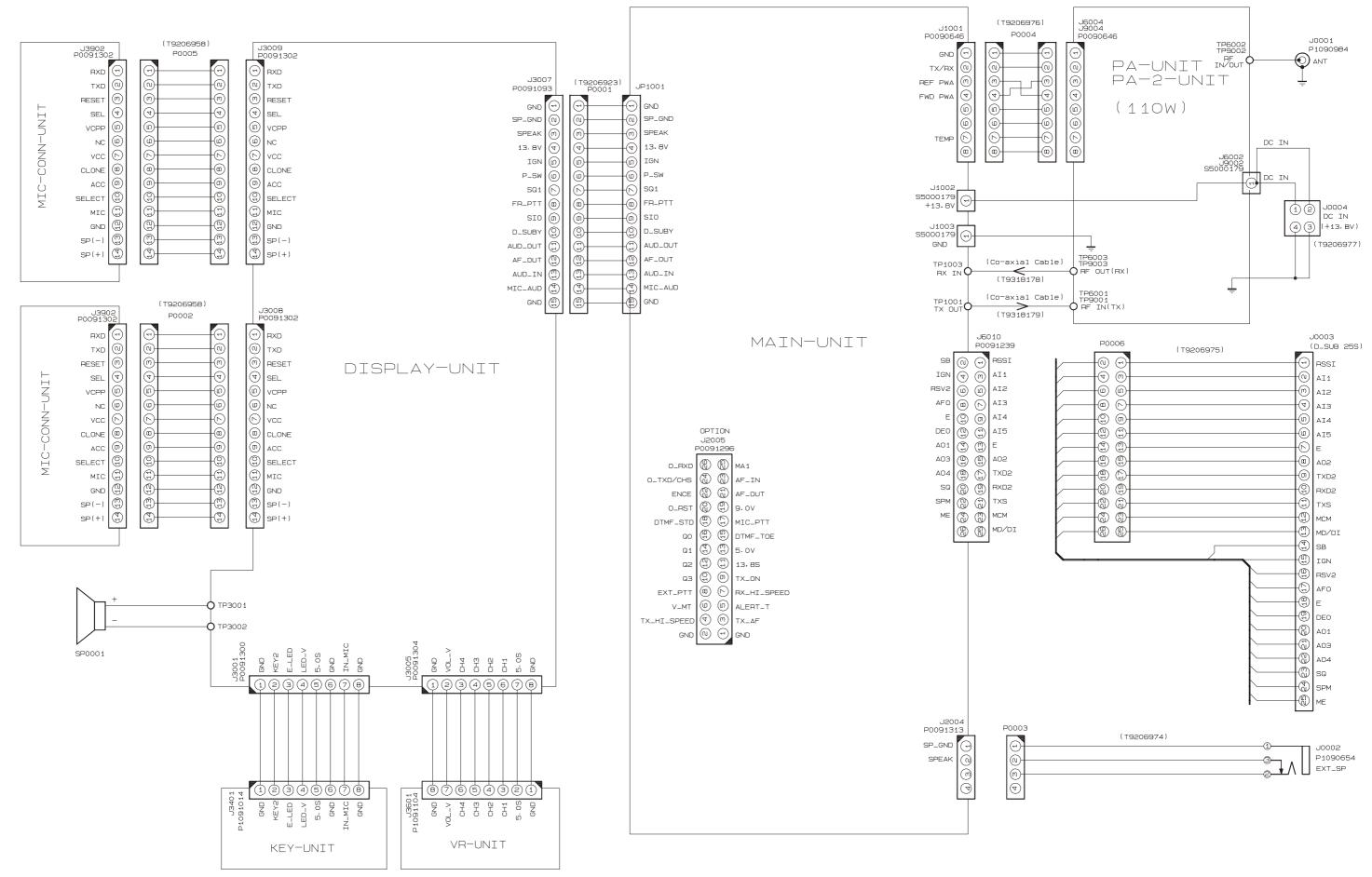
Block Diagram: MAIN Unit & PA Unit (2)



Block Diagram: MAIN Unit & PA-2 Unit



Block Diagram: DISPLAY Unit



Interconnection Diagram

Circuit Description

Transceiver functions, such as PLL synthesizer settings and channel programming, are controlled via the microprocessor unit (MPU). Reception and transmission are switched by "RX" and "TX" lines, also controlled from the MPU.

Main Receiver Signal Path

The receiver uses double-conversion superheterodyne circuitry, with a 43.95 MHz 1st IF and 450 kHz 2nd IF. The 1st LO, produced by a PLL synthesizer, yields the 43.95 MHz 1st IF. The 2nd LO uses a 43.5 MHz (43.95 MHz - 450 kHz) signal generated by a crystal oscillator. The 2nd mixer and other circuits use a custom IC to convert and amplify the 2nd IF, and detect FM to obtain demodulated signals.

Incoming RF signals from the antenna connector are delivered to the PA Unit or PA-2 Unit.

In the PA Unit, the RF signals pass through a lowpass filter (LPF) network consisting of coils L6009, L6008, and L6007, capacitors C6041, C6047, C6040, C6050, C6039, and C6027, and the antenna switching relay for delivery to the receiver front end in the Main Unit.

In the PA-2 Unit, the RF signals pass through a low-pass filter (LPF) network consisting of coils L9009, L9008, and L9007, capacitors C9041, C6047, C9040, C9050, C9039, and C9027, and the antenna switching relay for delivery to the receiver front end in the Main Unit.

Signals within the frequency range of the transceiver are then passed through a varactor-tuned band-pass filter consisting of L1007 and L1020 before RF amplification by Q1018 (**2SC3356**).

The amplified RF is then band-pass filtered again by varactor-tuned resonators L1009 and L1011 before and then to ensure pure in-band input to 1st mixer consisting of trances T1001, FET Q1043 (**SPM5001**).

Buffered output from the VCO Unit is amplified by Q1032 (**2SC4227**) and low-pass filtered by L1041, L1045 and C1153, C1154 and C1174 to provide a pure 1st local signal between 191.95 and 217.95 MHz for input to the 1st mixer.

The 43.95 MHz first mixer product then passes through second RF amplification by Q1030 (**2SC3356**) and dual monolithic crystal filters XF1001 and XF1002 (7.5 kHz BW) for wide band or XF1003 and XF1004 (3.75 kHz BW) for narrow band, and is amplified by Q1041 (**2SC4226**) and delivered to the input of the FM IF subsystem IC, Q1034 (**TA31136FN**). This IC contains the 2nd mixer, 2nd local oscillator, limiter amplifier, FM detector, noise amplifier, and squelch gate. The 2nd LO in the IF-IC is produced from TCXO X1001 (14.500 MHz), and the 1st IF is converted to 450 kHz by the 2nd mixer and stripped of unwanted components by ceramic filter CF1001 or CF1002. After passing through a limiter amplifier, the signal is demodulated by the FM detector.

Demodulated receive audio from the IF-IC is amplified by Q1036 (**2SA1602A**), Q2019 (**CXA1846N**). After volume adjustment by the AF power amplifier Q2018 (**TDA7240AV**), the audio signal is passed to the speaker jack or the internal 4-Ohm loudspeaker.

PLL Synthesizer

The 1st LO maintains stability from the PLL synthesizer by using a 14.500 MHz reference signal from TCXO X1001. PLL synthesizer IC Q1033 (**SA7025DK**) consists of a prescaler, reference counter, swallow counter, programmable counter, a serial data input port to set these counters based on the external data, a phase comparator, and charge pump. The PLL-IC divides the 14.500 MHz reference signal by 725 using the reference counter (20.0 kHz comparison frequency). The phase detector comparison frequency is designed to be eight times the channel spacing (2.5 kHz). The VCO output is divided by the prescaler, swallow counter, and programmable counter. These two signals are compared by the phase comparator and sent to the charge pump. A voltage proportional to their phase difference is delivered to the lowpass filter circuit, then fed back to the VCO as a voltage with phase error, controlling and stabilizing the oscillating frequency. This synthesizer also operates as a modulator during transmit.

The RX-VCO is composed of Q1019 (2SK520) and D1010, D1011, D1016, D1018 (all **HVU306A**), and oscillates between 191.95 MHz and 217.95 MHz according to the programmed receiving frequency. And the TX-VCO is composed of Q1020 (**2SC5107**) and D1014 and D1015 (both**HVU306A**), and oscillates between 148.0 MHz and 174.0 MHz according to the programmed transmit frequency. The VCO output passes through buffer amplifier Q1026 (**2SC5107**), and a portion is fed to the buffer amplifier Q1029 (2SC5107) of the PLL IC, and at the same time amplified by Q1032 (**2SC4227**) to obtain stable output. The VCO DC supply is regulated by Q1006 (2SC4154E). Synthesizer output is fed to the 1st mixer by diode switch D1025 (1SS321) during receive, and to drive amplifier Q1031 (**2SC5415E**) and Q1025 (**2SC2954**) for transmit. The reference oscillator feeds the PLL synthesizer, and is composed of TCXO X1001 (14.500 MHz).

Circuit Description

Transmitter

During transmit, the PLL synthesizer oscillates at the desired frequency directly, for amplification to obtain RF power output. During transmission, voice modulation and CTCSS (or DCS) modulation are applied to this synthesizer.

Voice audio from the microphone is amplified by the microphone amplifier Q3039 (**NJM2902V**) in the DISPLAY Unit, and then deliver to the MAIN Unit.

The amplified audio is supplied to Q2001 (**NJM2902V**) through the amplifier Q2041 (**NJM2902V**). Q2001consists of the pre-emphasis, limiter (IDC instantaneous deviation control), and low-pass filter; the signal is adjusted for optimum deviation level and delivered to the next stage.

Voice inputs from the microphone and CTCSS are FM-modulated at the VCO of the synthesizer, while DCS audio is modulated by the reference frequency oscillator of the synthesizer.

Synthesizer output, after passing through diode switch D1025 (**1SS321**), is amplified by drivers Q1031 (**2SC5415E**) and Q1025 (**2SC2954**) and power module Q1017 (early model: **M67781H**, current model: **RA60H1317M** for PA Unit or **RA30H1317M1A** for PA-2 Unit) to obtain the required RF drive prior to delivery to the PA Unit or PA-2 Unit.

In the PA Unit, the RF signal is amplified by parallel junction transistors Q6001/Q6002 (early model: both **2SC5125**, current model: both **2SC2782A**) and passes through antenna switching relay RL6001 and a low-pass filter circuit, and ultimately to the antenna connector.

RF output power from the final amplifier is sampled by a CM coupler and is rectified by D6002 and D6003 (both **HSM88AS**). The resulting DC is fed through Automatic Power Controller Q1007 (**NJM2902V**), Q1002 (**2SB1143S**: early model only) to control the gain of the transmitter RF amplifier and thus regulate the power output.

Generation of spurious products by the transmitter is minimized by the fundamental carrier frequency being equal to the final transmitting frequency, modulated directly in the transmit VCO. Additional harmonic suppression is provided by a low-pass filter consisting of L6007, L6008, L6009, and C6027, C6039, C6050, C6040, C6047 and C6041, resulting in more than 65 dB of harmonic suppression prior to delivery of the RF energy to the antenna. In the PA-2 Unit, the RF signal is amplified by parallel junction transistors Q9001/Q9002 (both **RD70HVF1**) and passes through antenna switching relay RL9001 and a low-pass filter circuit, and ultimately to the antenna connector.

RF output power from the final amplifier is sampled by a CM coupler and is rectified by D9002 and D9003 (both **HSM88AS**). The resulting DC is fed through Automatic Power Controller Q1007 (**NJM2902V**) to control the gain of the transmitter RF amplifier and thus regulate the power output.

Generation of spurious products by the transmitter is minimized by the fundamental carrier frequency being equal to the final transmitting frequency, modulated directly in the transmit VCO. Additional harmonic suppression is provided by a low-pass filter consisting of L9007, L9008, L9009, and C9027, C9039, C9050, C9040, C9047 and C9041, resulting in more than 65 dB of harmonic suppression prior to delivery of the RF energy to the antenna.

DCS Demodulator

DCS signals are demodulated on the MAIN-UNIT, and are applied to low-pass filter Q2040 (**NJM2902V**), as well as the limiter comparator Q2040 (**NJM2902V**).

CTCSS Encoder/Decoder

The CTCSS code is generated and encoded by MPU IC Q2025 (**MB90F583B**). Demodulation and detection of the CTCSS tones are carried out by IC Q2017 (**MX165C**).

MPU

Operation is controlled by 16-bit MPU IC Q2025 (**MB90F583B**). The system clock uses a 16.000 MHz crystal for a time base. IC Q2035 (**RN5VL35AA**) resets the MPU when the power is on, and monitors the voltage of the regulated 5V power supply line.

EEPROM

The EEPROM retains Tx and Rx data for all memory channels, as well as CTCSS data, DCS data, prescaler dividing, and REF oscillator data (internal/external). The VX-6000 has been carefully aligned at the factory for the specified performance across the frequency range specified for each version.

Realignment should therefore not be necessary except in the event of a component failure, or when altering the transceiver version. If a sudden problem occurs during normal operation, it is likely due to component failure; realignment should not be done until after the faulty component has been replaced. All component replacement and service should be performed only by an authorized **VERTEX STANDARD** representative, or the warranty policy may be voided. Therefore, if a fault is suspected, contact the dealer from whom the transceiver was purchased for instructions regarding repair.

Authorized **VERTEX STANDARD** service technicians realign all circuits and make complete performance checks to ensure compliance with factory specifications after replacing any faulty components. Those who do undertake any of the following alignments are cautioned to proceed at their own risk. Problems caused by unauthorized attempts at realignment are not covered by the warranty policy. Also, **VERTEX STANDARD** must reserve the right to change circuits and alignment procedures in the interest of improved performance, without notifying owners.

Under no circumstances should any alignment be attempted unless the normal function and operation of the transceiver are clearly understood, the cause of the malfunction has been clearly pinpointed and any faulty components replaced, and the need for realignment determined to be absolutely necessary.

Required Test Equipment

The following test equipment (and thorough familiarity with its correct use) is necessary for complete realignment. Correction of problems caused by misalignment resulting from use of improper test equipment is not covered under the warranty policy.

While most steps do not require all of the equipment listed, the interactions of some adjustments may require that more complex adjustments be performed afterwards. Do not attempt to perform only a single step unless it is clearly isolated electrically from all other steps. Have all test equipment ready before beginning, and follow all of the steps in a section in the order presented.

- RF signal generator: calibrated output level at 1000 MHz
- Deviation Meter (linear detector)
- □ AF Millivoltmeter
- □ SINAD Meter
- □ Inline Wattmeter with 5% accuracy at 1000 MHz
- Regulated DC Power Supply: adjustable from 10 to 17 VDC, 35A
- 50-ohm non-reactive Dummy Load: 200 W at 1000 MHz
- Frequency Counter: <0.1 ppm accuracy at 1000 MHz</p>
- □ AF Signal Generator
- DC Voltmeter: high impedance
- □ RF Sampling Coupler (attenuation pad)
- □ Oscilloscope
- □ Spectrum Analyzer
- Vertex Standard SVC49 channel programming editor.
- □ IBM[®] PC/Compatible computer with Microsoft[®] Windows[®] 2000, XP, Vista or 7.
- Vertex Standard FIF-12 USB Programming Interface and T9101628 Connection Cable.
- Vertex Standard FRB-6 Tuning Interface Box and CT-161 Programming Cable.

Alignment Preparation & Precautions

A dummy load and inline wattmeter must be connected to the main antenna jack in all procedures that call for transmission, except where specified otherwise. Correct alignment is not possible with an antenna. After completing one step, read the following step to determine whether the same test equipment will be required. If not, remove the test equipment (except dummy load and wattmeter, if connected) before proceeding.

Correct alignment requires that the ambient temperature be the same as that of the transceiver and test equipment, and that this temperature be held constant between 68° and 86°F (20° ~ 30°C). When the transceiver is brought into the shop from hot or cold air it should be allowed some time for thermal equalization with the environment before alignment. If possible, alignments should be made with oscillator shields and circuit boards firmly affixed in place. Also, the test equipment must be thoroughly warmed up before beginning. Before beginning, connect the transceiver and PC using the FIF-12 USB Programming Interface and T9101628 Connection Cable, then download the EE-PROM data from the transceiver to the computer.

Store this data in a disk file so that it can be saved and retrieved later. Using the table below, program the channel, CTCSS, and DCS alignment settings for your transceiver version. Upload this file to the transceiver.

Note: Signal levels in dB referred to in this procedure are based on 0 dB μ = 0.5 μ V (closed circuit).

Alignment Channel Frequencies

Channel	Frequency (simplex)	CTCSS Encode	DCS Encode	Narrow/Wide
CH1	148.01 MHz	None	None	Wide
CH2	161.01 MHz	None	None	Wide
CH3	173.99 MHz	None	None	Wide
CH4	148.01 MHz	None	None	Narrow
CH5	161.01 MHz	None	None	Narrow
CH6	173.99 MHz	None	None	Narrow
CH7	161.01 MHz	151.4 Hz	None	Wide
CH8	161.01 MHz	None	023	Wide
CH9	161.01 MHz	151.4 Hz	None	Narrow
CH10	161.01 MHz	None	023	Narrow

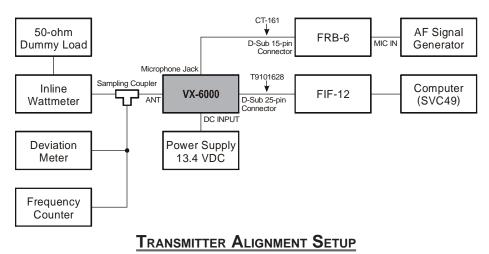
PLL & Transmitter

Set up the test equipment as shown for transmitter alignment.

Maintain the supply voltage at 13.4 V DC for all steps.

PLL VCV

- Connect the positive lead of the DC voltmeter to test point **TP1008** (VCV) on the Main Unit, as indicated in the figure, and connect the negative lead to chassis ground.
- Set the transceiver to the low band edge frequency channel (CH1 or CH4), then adjust **TC1001** on the Main Unit for 1.6 V ± 0.1 V on the voltmeter.
- ☐ Key the transmitter, and adjust **TC1002** on the Main Unit for 1.85 V ±0.1 V on the voltmeter.
- Next select to the high edge frequency channel (CH3 or CH6) and confirm the VCV is less than 7.0 V on the voltmeter.
- ☐ Key the transmitter, and confirm the VCV is less than 7.0 V on the voltmeter.



Transmitter Output Power

The following transmitter parameters can be adjusted from the computer by utilizing the Alignment Software. Refer to the onboard help of the Alignment Software Manual for details.

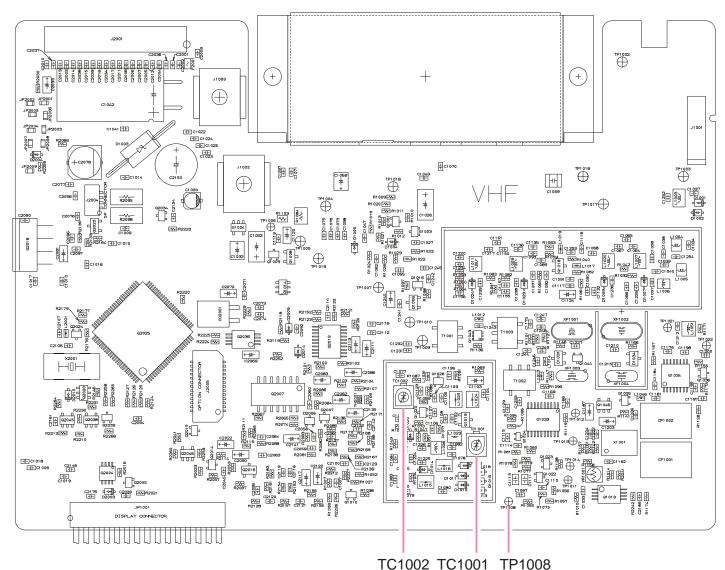
- Select the band center frequency channel (CH2 or CH5), and select the "high" power output level. Key the transmitter and adjust "TX PWR Hi" for a power output of 110 Watts (± 3.0 W) as indicated on the wattmeter.
- Stay on the band center frequency channel (CH2 or CH5), and select the "low" power output level. Key the transmitter and adjust "TX PWR L3" for a power level of 50 Watts (± 2.0 W) as indicated on the wattmeter.

Transmitter Deviation

The following modulation parameters can be adjusted from the computer by utilizing the Alignment Software. Refer to the onboard help of the Alignment Software Manual for details.

Microphone Audio Modulation Level

- Select the band center frequency channel (CH2), and select the "low" power output level.
- □ Adjust the AF generator for 50mV (-30dBm) output at 1 kHz, as applied to the microphone jack.
- □ Key the transmitter and adjust "MAX Dev (wide)" for maxi-mum deviation of 4.2 kHz ± 0.2 kHz as indicated on the deviation meter.
- Select the band center frequency channel (CH5), and select the "low" power output level.
- □ Adjustdjust the AF generator for 50mV (-30dBm) output at 1 kHz, as applied to the microphone jack.
- Key the transmitter and adjust "MAX Dev (Narrow)" for maximum deviation of 2.1 kHz ± 0.1 kHz as indicated on the deviation meter.



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CTCSS Modulation Level

- □ Select the "low" power output level.
- Select the band center frequency channel (CH7), with 151.4 Hz CTCSS encode, and reduce the AF generator injection to zero.
- Key the transmitter and adjust "CTCSS Dev (wide)" for CTCSS deviation of 0.75 kHz ± 0.05 kHz as indicated on the deviation meter.
- Select the band center frequency channel (CH9), with 151.4 Hz CTCSS encode, and reduce the AF generator injection to zero.
- Key the transmitter and adjust "CTCSS Dev (Narrow)" for CTCSS deviation of ±0.36 kHz (± 0.05 kHz) as indicated on the deviation meter.

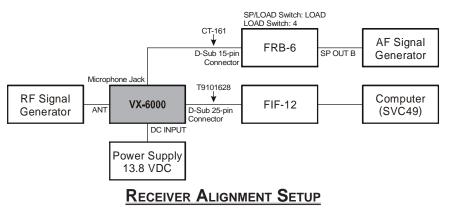
DCS Modulation Level

- □ Select the "low" power output level.
- Select the band center frequency channel (CH8), with 023 DCS code, and reduce the AF generator injection to zero.
- □ Key the transmitter and adjust "DCS Dev (wide)" for DCS deviation of ±0.75 kHz (± 0.05 kHz) as indicated on the deviation meter.
- Select the band center frequency channel (CH10), with 023 DCS code, and reduce the AF generator injection to zero.
- Key the transmitter and adjust "DCS Dev (Narrow)" for CTCSS deviation of ±0.36 kHz (± 0.05 kHz) as indicated on the deviation meter.

Receiver

The sensitivity parameters can be adjusted from the computer by utilizing the Alignment Software. Refer to the onboard help of the Alignment Software Manual for details.

- Set up the test equipment as shown for receiver alignment. Maintain the supply voltage at 13.8 V DC for all steps.
- □ With the transceiver set to the band center frequency channel (CH2), and with the RF signal generator tuned to the same frequency, set the generator for ±3.0 kHz deviation with 1 kHz tone modulation, and set the output level for −5.0 dBµ at the antenna jack.
- Adjust "Rx TUNE" the receiver front-end tuning for optimum SINAD, reducing signal generator output level as necessary for proper meter deflection.
- □ After the previous step, the final signal generator level should be less than -5.0 dBµ for 12dB SINAD.
- □ With the transceiver set to the band center frequency channel (CH5), and with the RF signal generator tuned to the same frequency, set the generator for ±1.5 kHz deviation with 1 kHz tone modulation, and set the output level for -4.0 dBµ at the antenna jack.
- □ After the previous step, and confirm the final signal generator level should be less than -4.0 dBµ for 12dB SINAD.



Squelch Threshold

The squelch parameters can also be adjusted from the computer by utilizing the Alignment Software. Refer to the onboard help of the Alignment Software Manual for details.

Tight SQL RSSI LEVEL (Wide)

□ Select the band center frequency channel (CH2), and with the RF signal generator turned to the same frequency, set the generator for ±3.0 kHz deviation with 1 kHz tone modulation, and set the output level for 1.0 dBµ at the antenna jack.

Threshold NSQ LEVEL (Wide)

Select the band center frequency channel (CH2), and with the RF signal generator turned to the same frequency, set the generator for ±3.0 kHz deviation with 1 kHz tone modulation, and set the output level for −6.0 dBµ at the antenna jack.

Tight SQL NSQ LEVEL (Wide)

□ Select the band center frequency channel (CH2), and with the RF signal generator turned to the same frequency, set the generator for ±3.0 kHz deviation with 1 kHz tone modulation, and set the output level for 1.0 dBµ at the antenna jack.

Tight SQL RSSI LEVEL (Narrow)

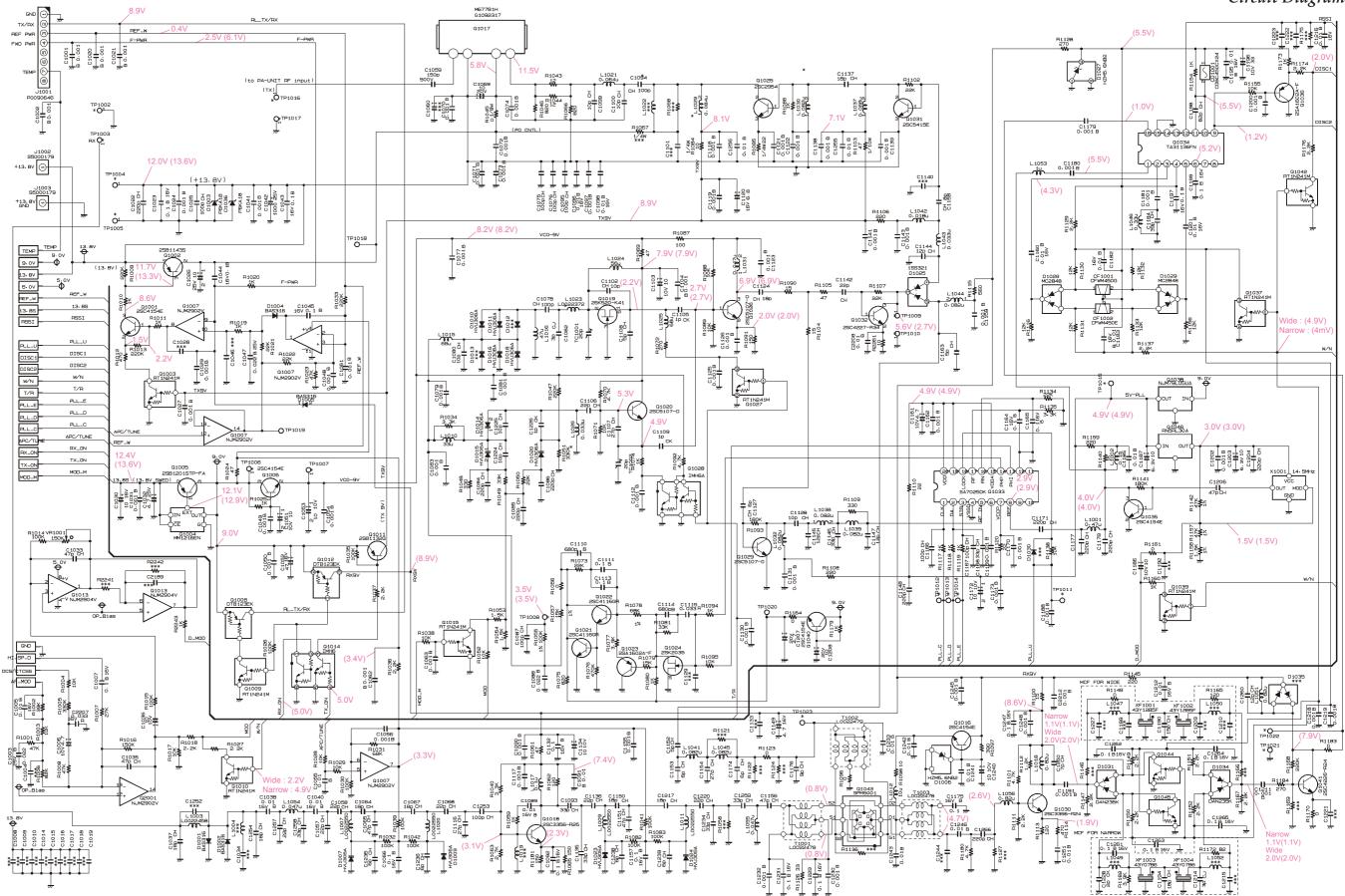
Select the band center frequency channel (CH5), and with the RF signal generator turned to the same frequency, set the generator for ±1.5 kHz deviation with 1 kHz tone modulation, and set the output level for 1.0 dBµ at the antenna jack.

Threshold NSQ LEVEL (Narrow)

□ Select the band center frequency channel (CH5), and with the RF signal generator turned to the same frequency, set the generator for ±1.5 kHz deviation with 1 kHz tone modulation, and set the output level for -6.0 dBµ at the antenna jack.

Tight SQL NSQ LEVEL (Narrow)

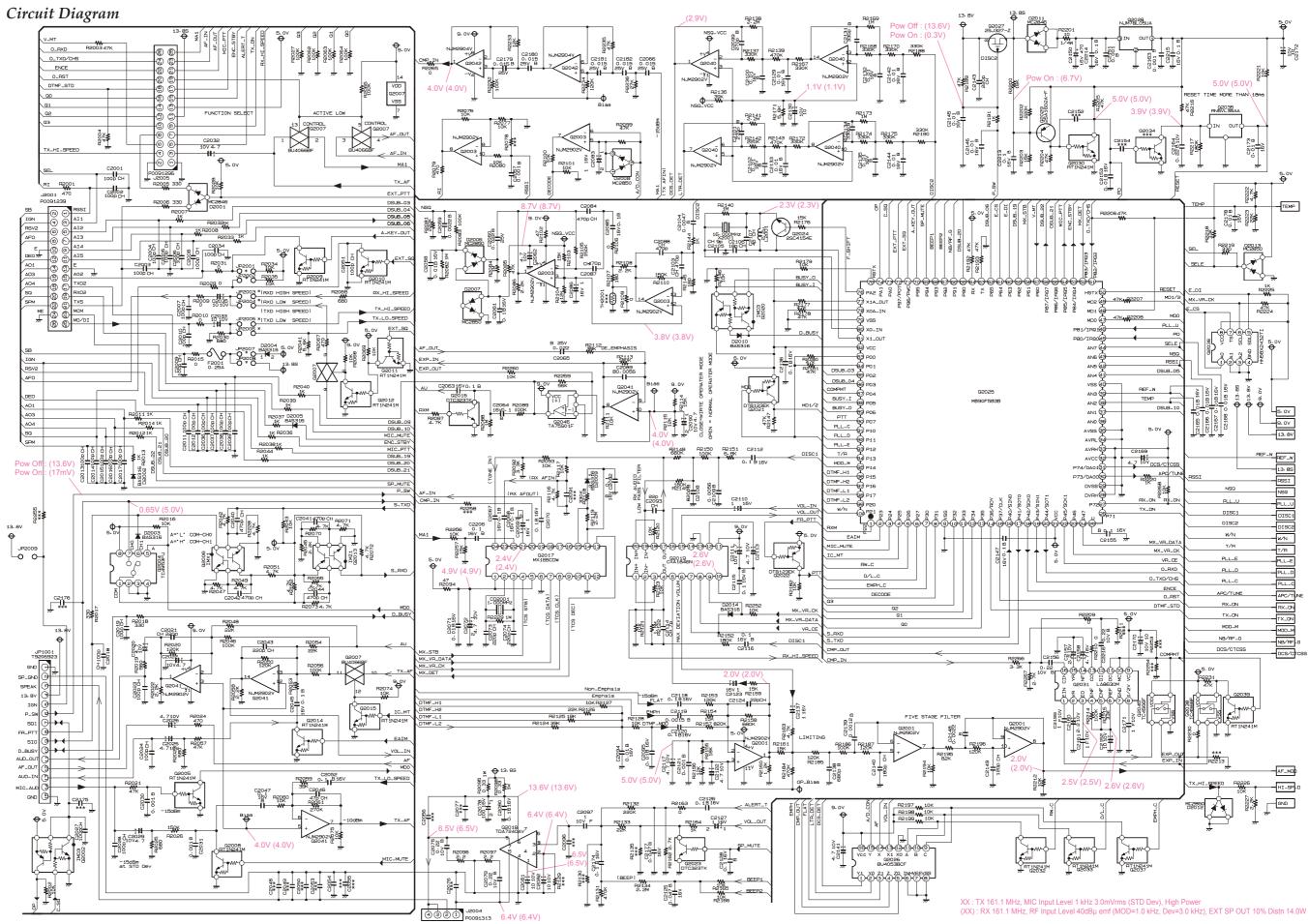
- Select the band center frequency channel (CH5), and with the RF signal generator turned to the same frequency, set the generator for ±1.5 kHz deviation with 1 kHz tone modulation, and set the output level for 1.0 dBµ at the antenna jack.
- Adjust the squelch threshold level "Tight SQL NSQ(Narrow)" such that the squelch just open at this signal input level (the BUSY LED will turn on).



XX : TX 161.1 MHz, MIC Input Level 1 kHz 3.0mVrms (STD Dev), High Power (XX) : RX 161.1 MHz, RF Input Level 40dBµ emf (MOD=1.0 kHz, Dev=3.0 kHz), EXT SP OUT 10% Distn 14.0W

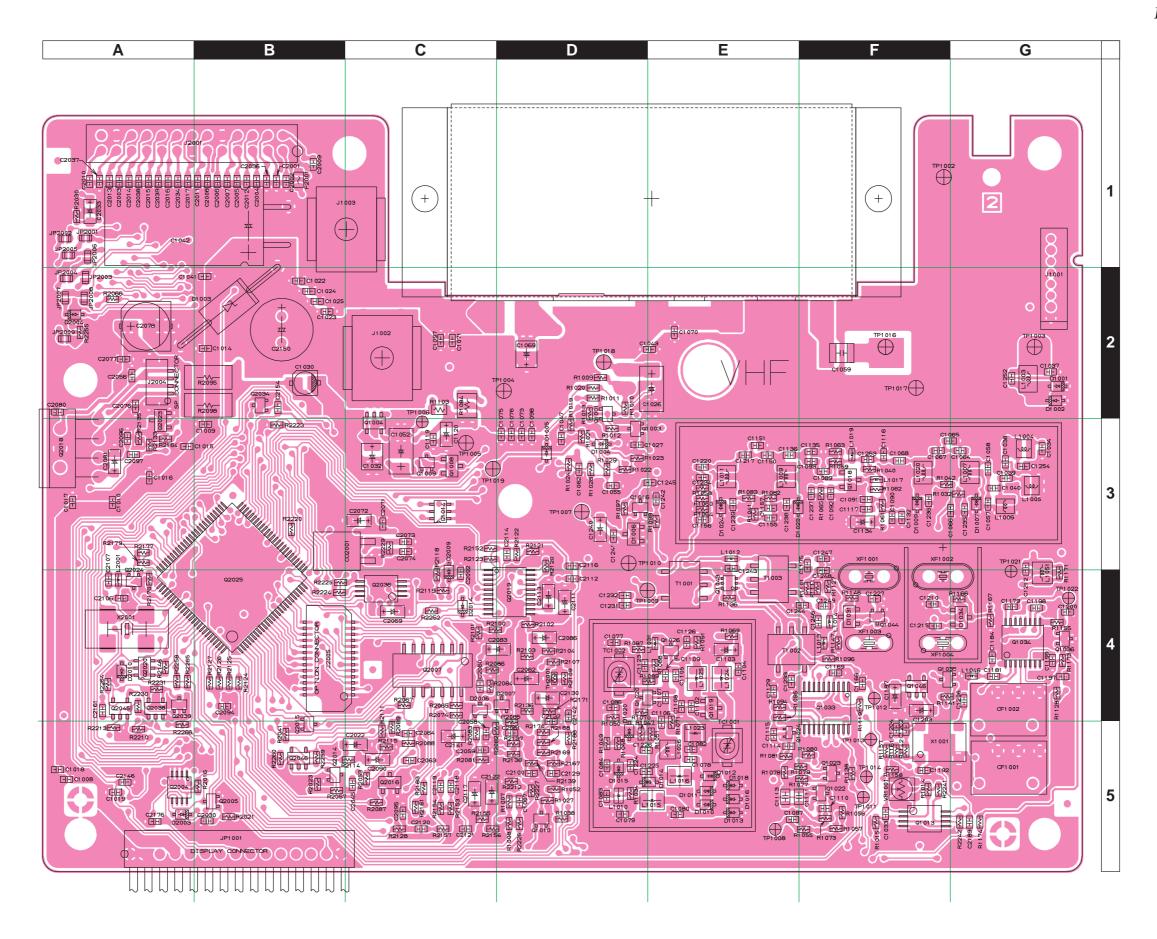
MAIN Unit (FR006760C)

Circuit Diagram



MAIN Unit (FR006760C)

10A-2



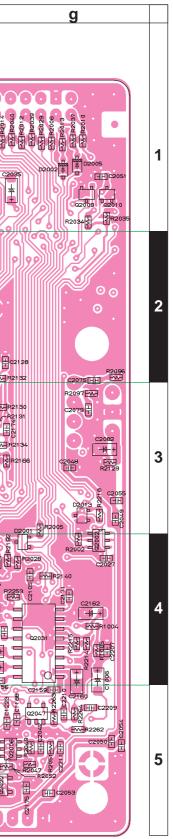
MAIN Unit (FR006760C)

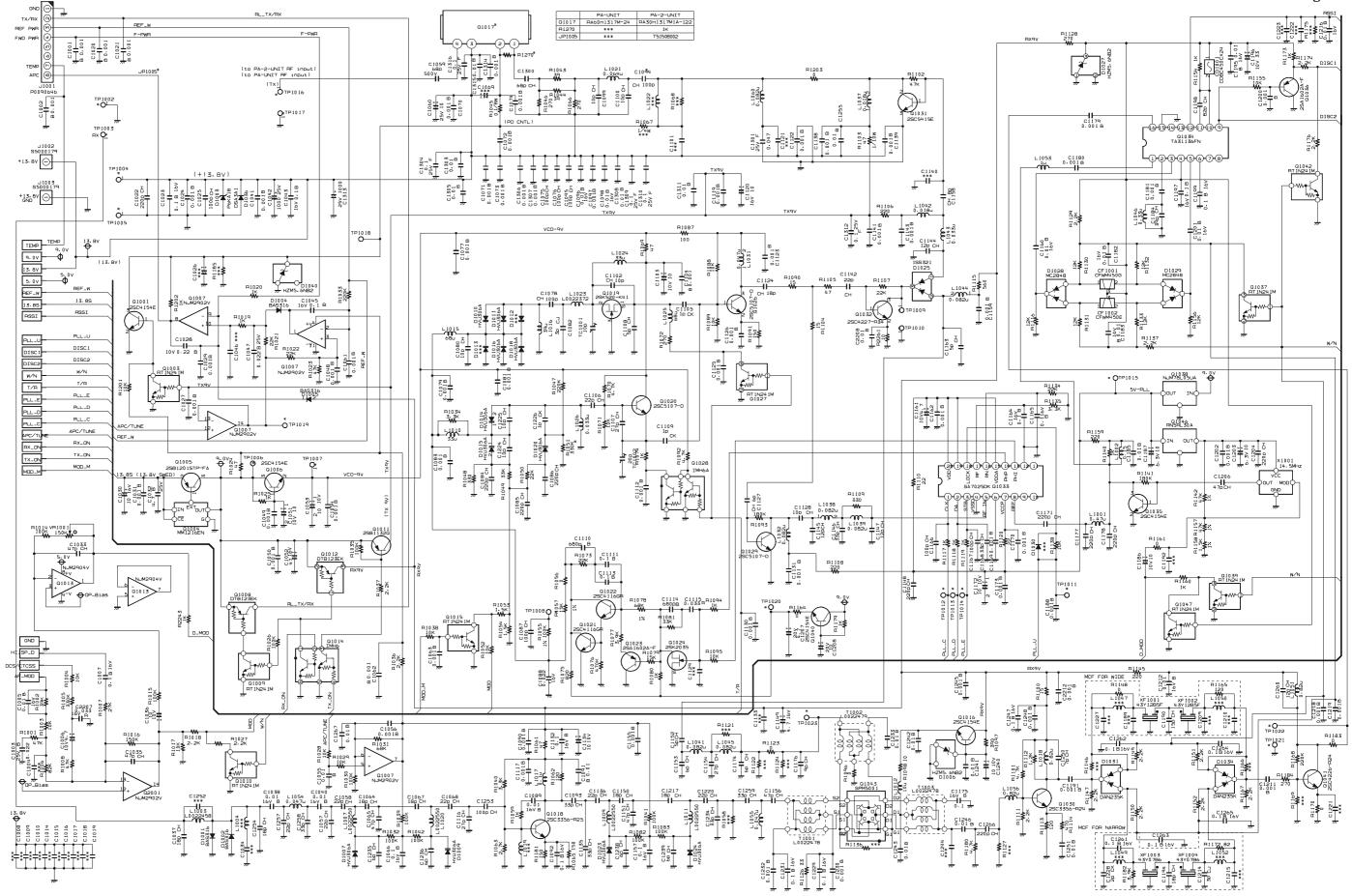
Parts Layout (Side A)

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MAIN Unit (FR006760C)

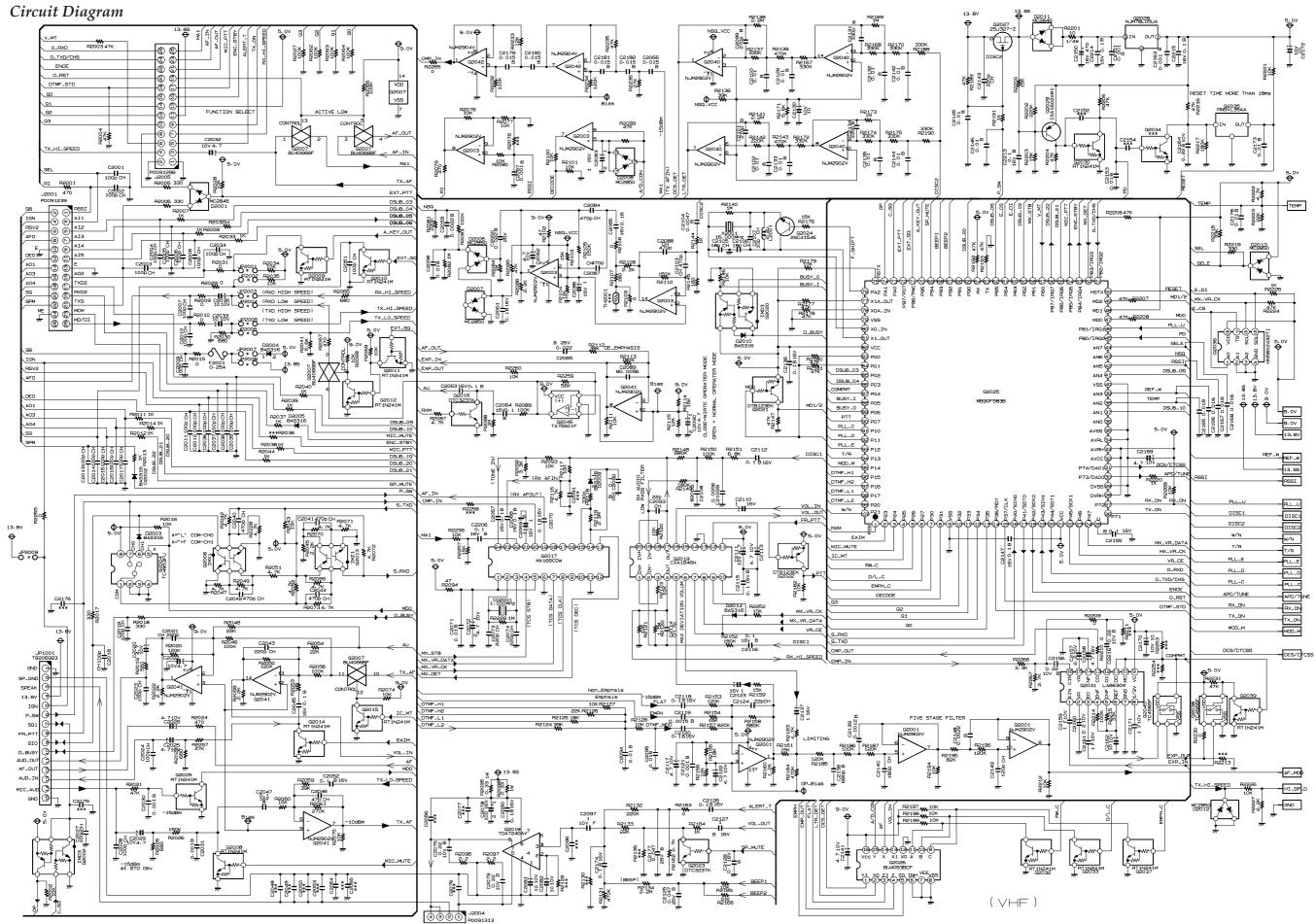
Parts Layout (Side B)



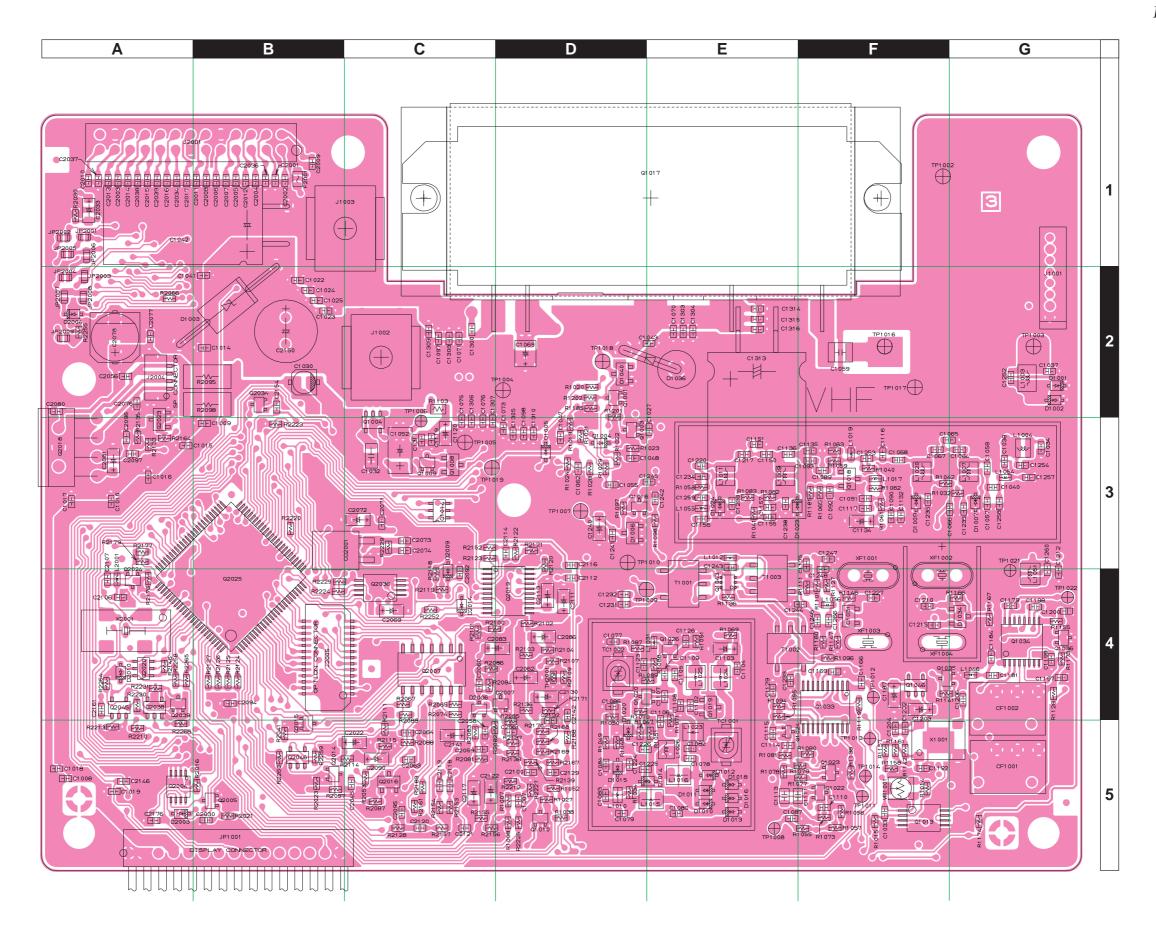


MAIN Unit (FR006760D)

Circuit Diagram



MAIN Unit (FR006760D)



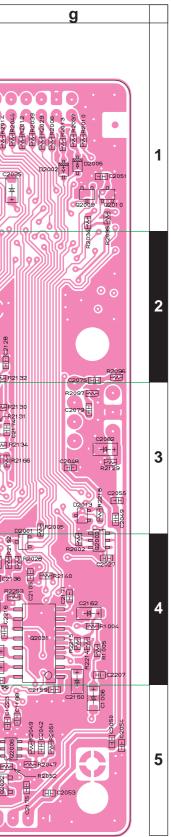
MAIN Unit (FR006760D)

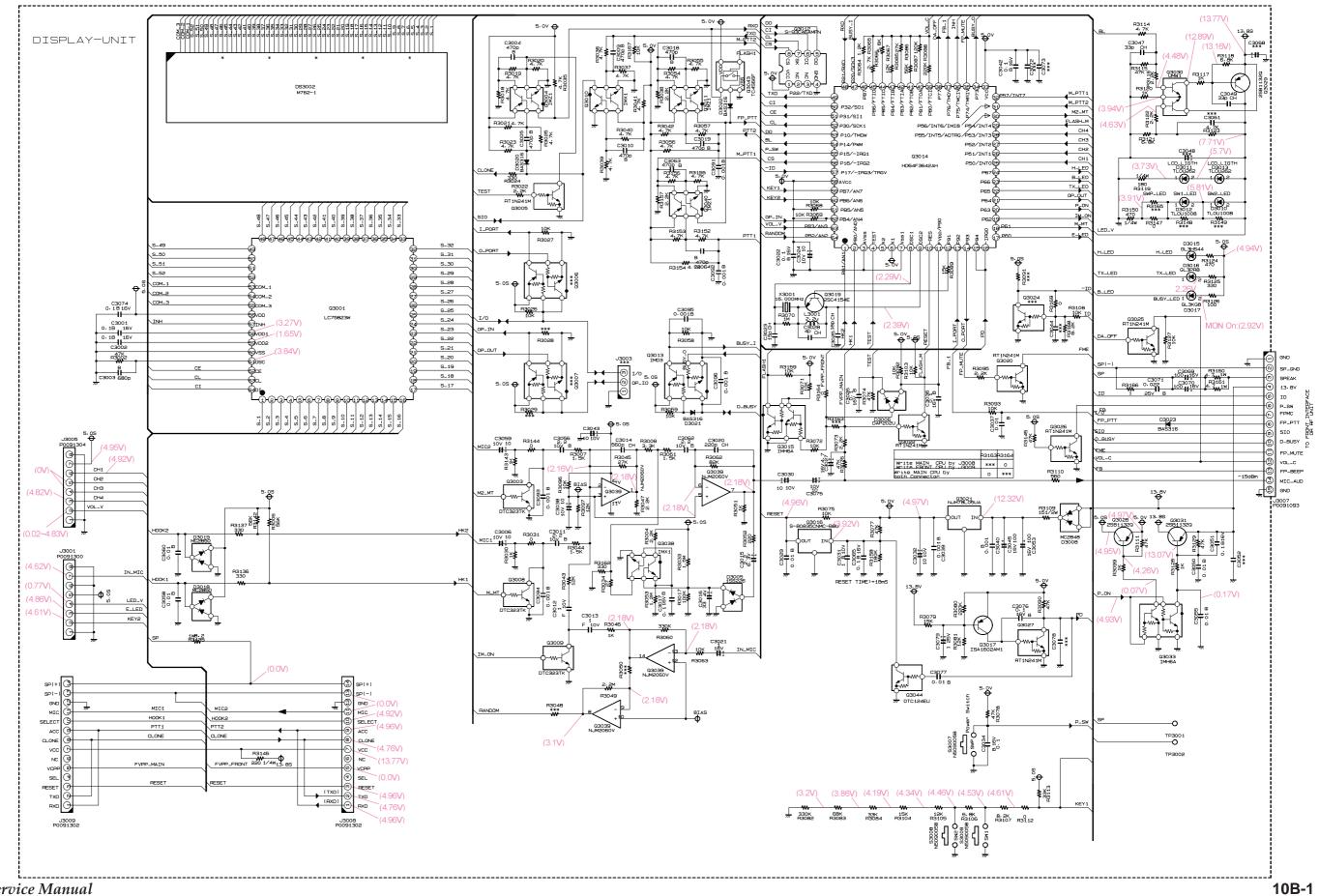
Parts Layout (Side A)

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CT 020						
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				±2017 ☐ C20	C2155 H H C2147	W R21 92
					C2:65 + + C2:1/27 * 67 C2:05 + C2:05 + C2:05 67 C2:05 + C2:07 + + 62:059 - - - + + 62:059 - - - - + + 62:059 - - - - + + + 62:069 - - - - - + + 62:05 - - - - - - +	E C21
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MAIN Unit (FR006760D)

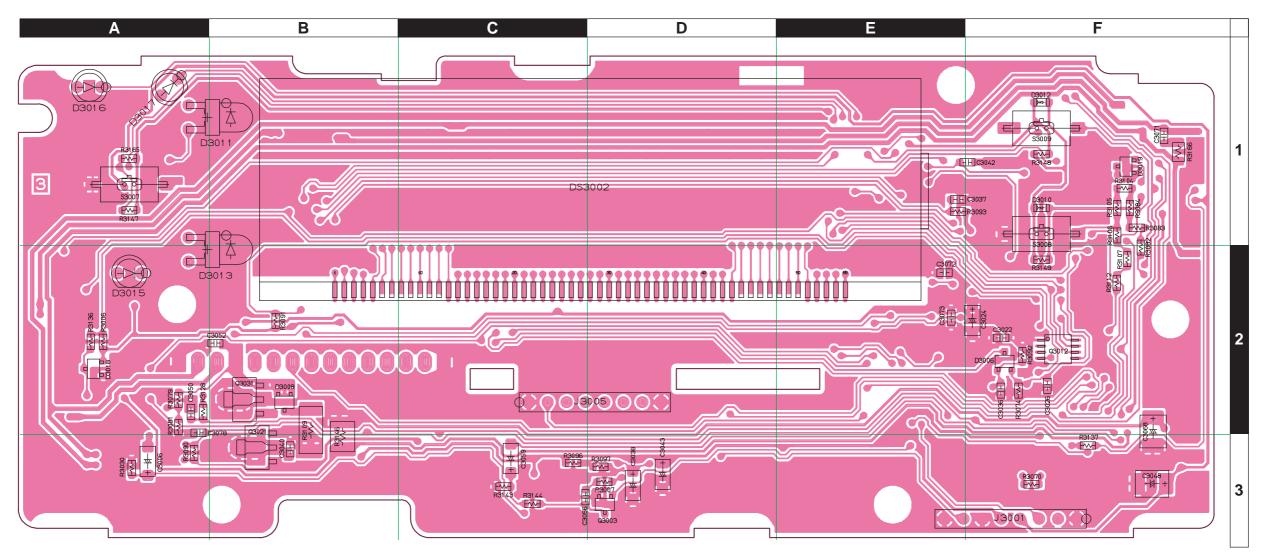
Parts Layout (Side B)





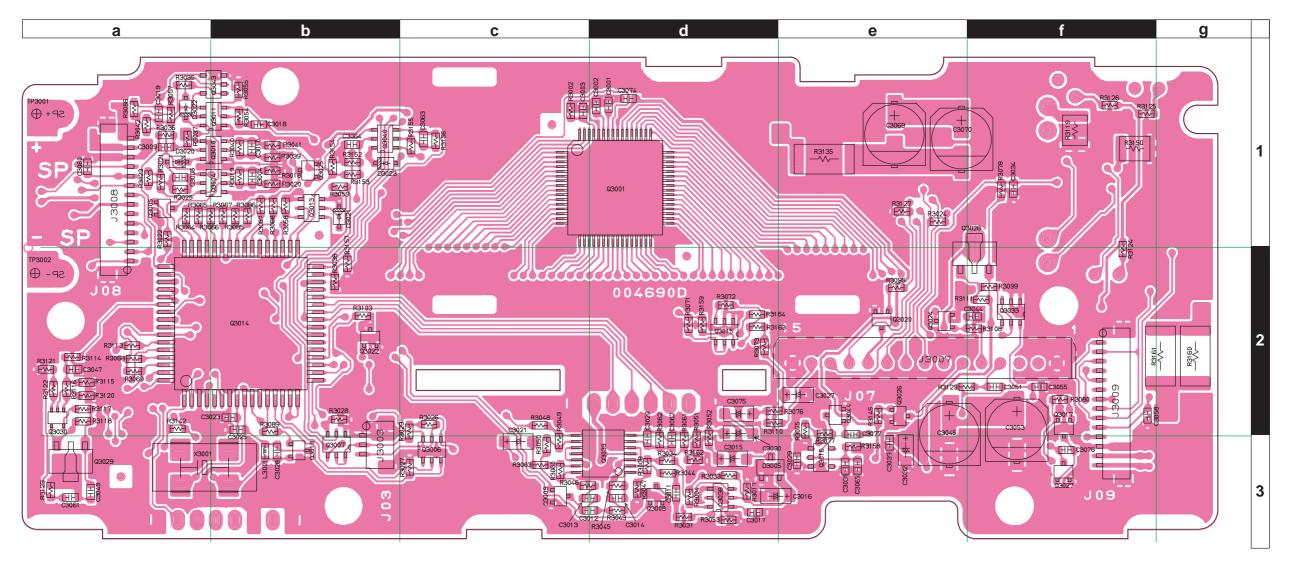
DISPLAY Unit (FR004690D)

Circuit Diagram



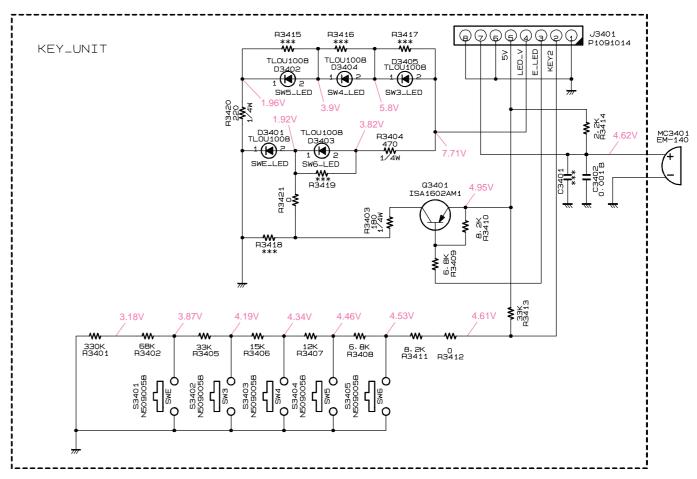
DISPLAY Unit (FR004690D)

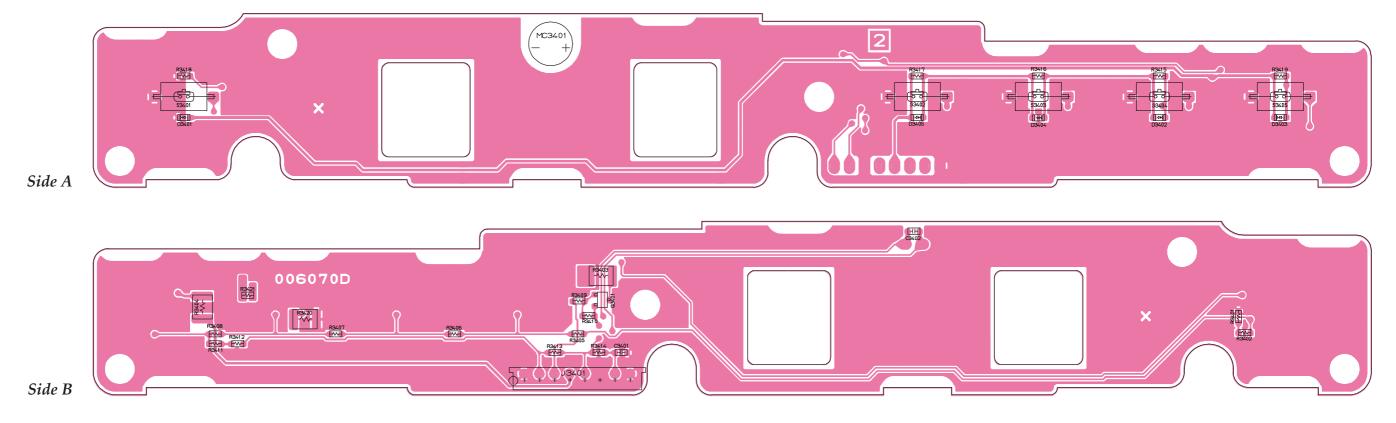
Parts Layout (Side A)



DISPLAY Unit (FR004690D)

Parts Layout (Side B)



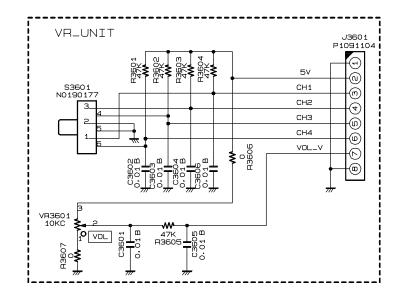


KEY Unit (FR006070D)

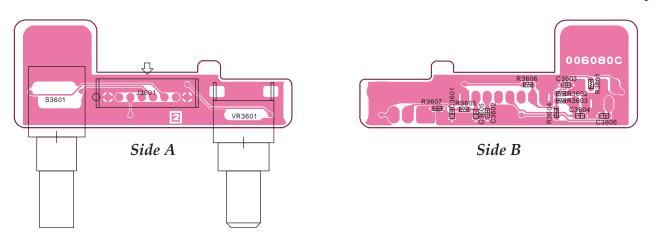
Circuit Diagram

VR Unit (FR006080C)

Circuit Diagram

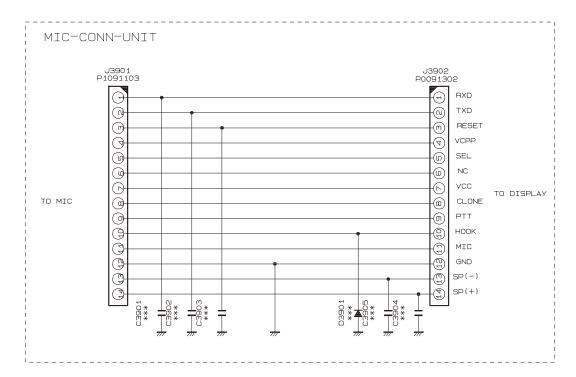


Parts Layout



MIC CONN Unit (FR006090C)

Circuit Diagram

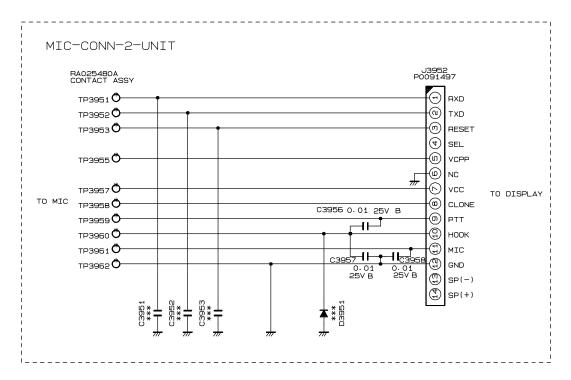


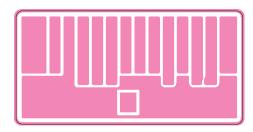
Parts Layout



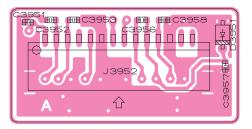


Side B

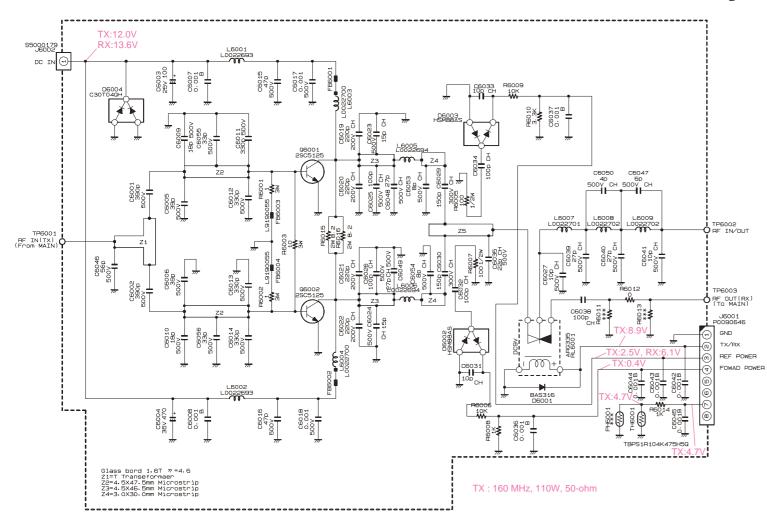


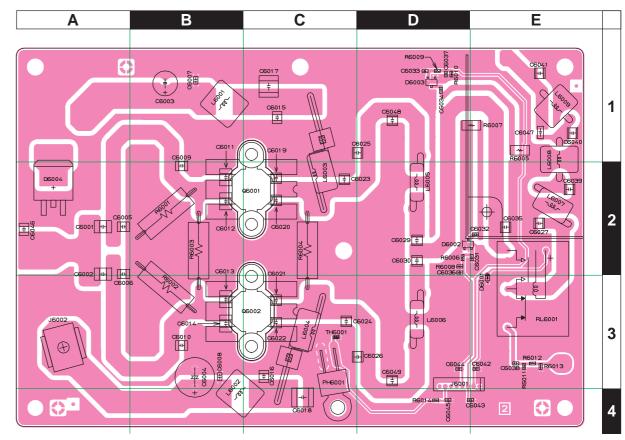


Side A

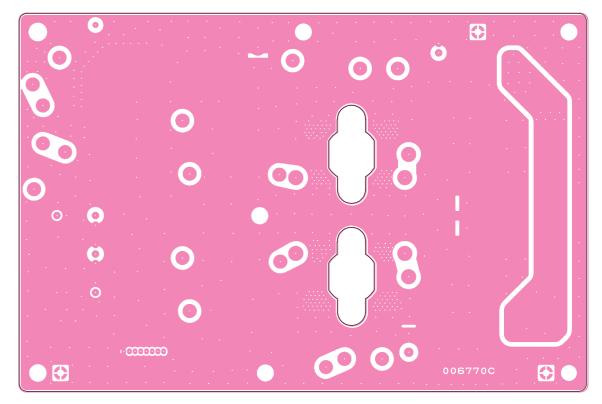


Side B

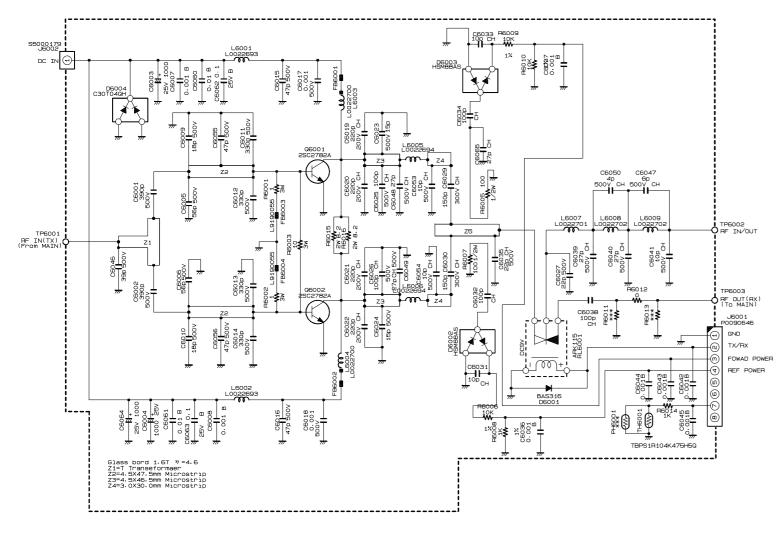


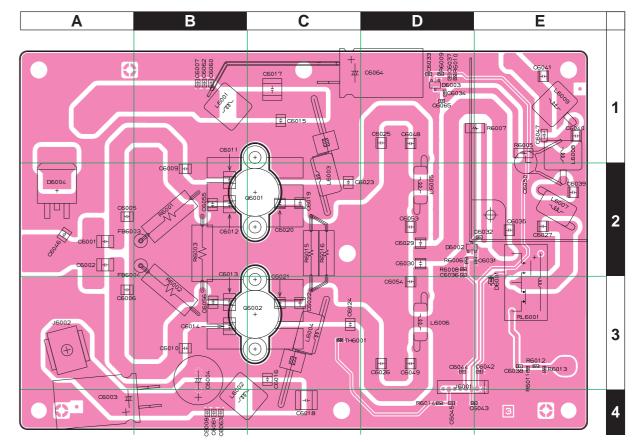


Side A

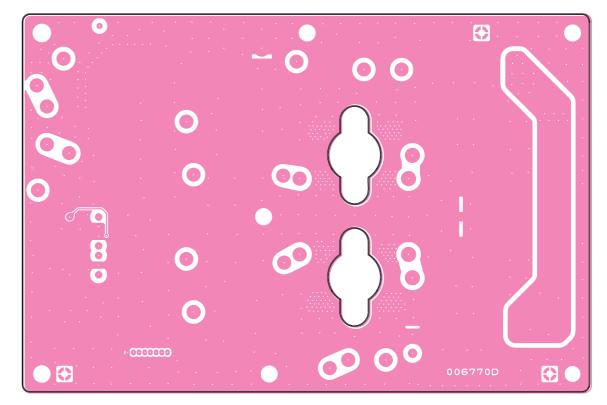


PA Unit (FR006770C)

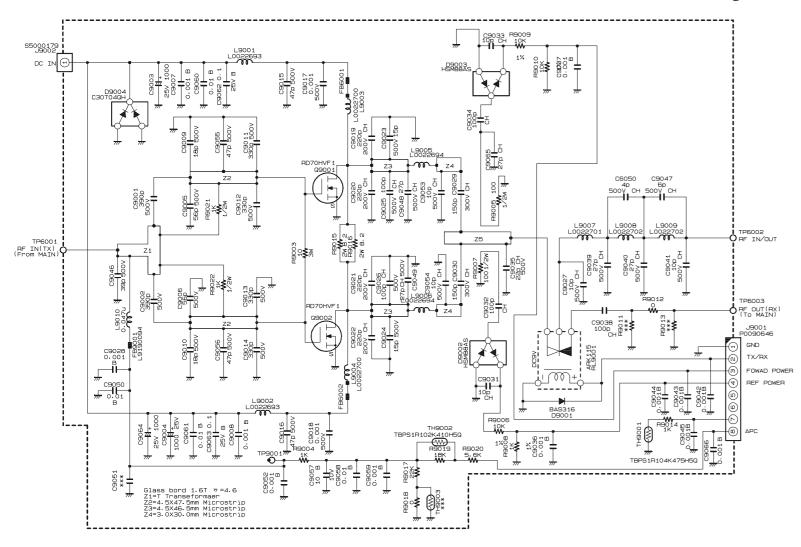


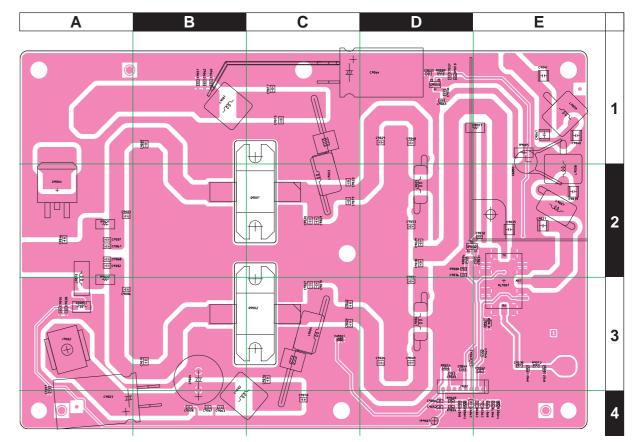


Side A

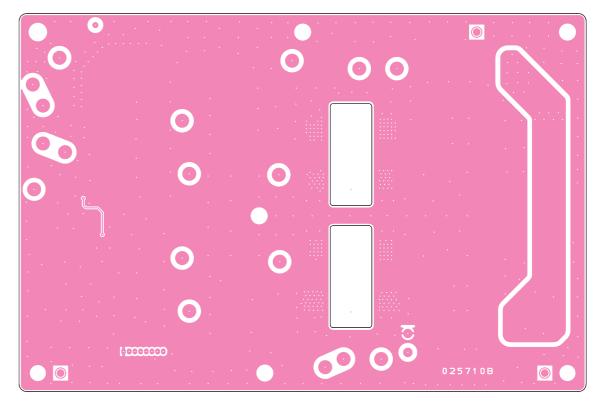


PA Unit (FR006770D)





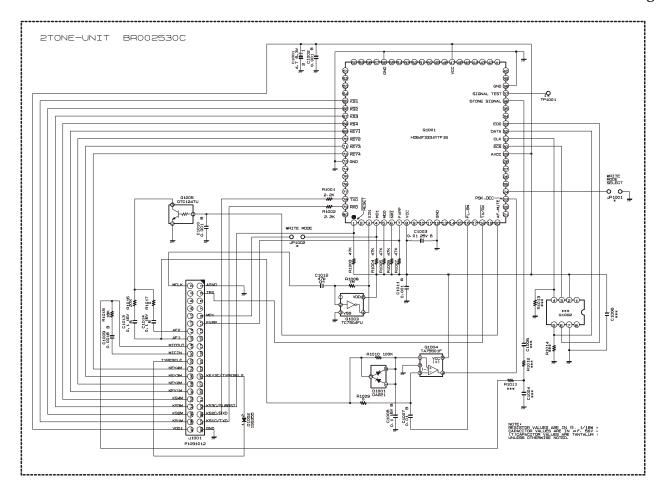
Side A

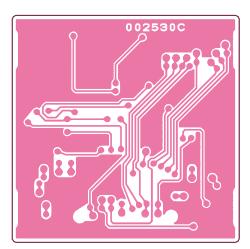


PA-2 Unit (RA025710B)

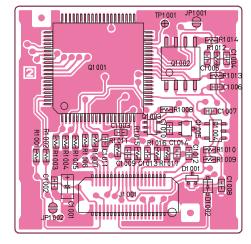
F2D-8 2-Tone Decode Unit (Option)

Circuit Diagram







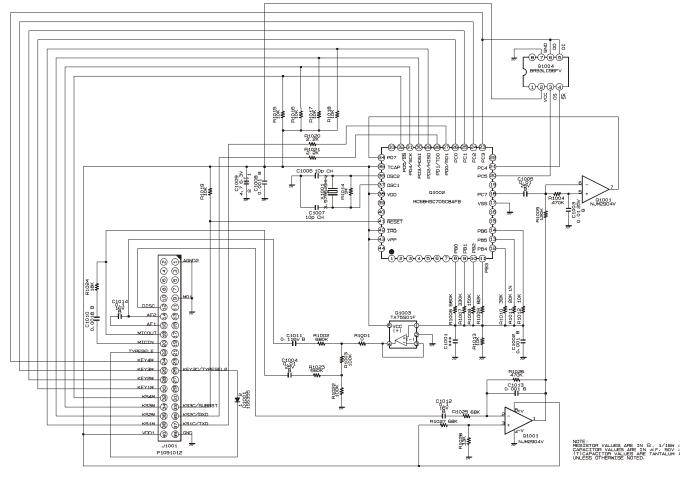


Side A

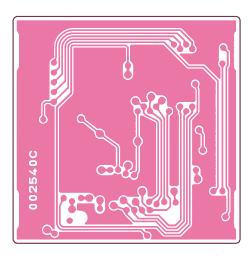
VTP-50 VX-Trunk Unit (Option)

Circuit Diagram

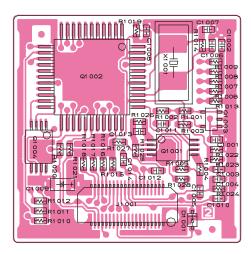




Parts Layout



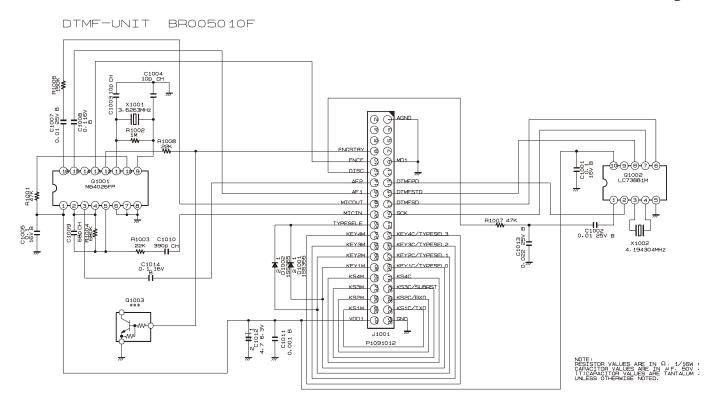
Side B

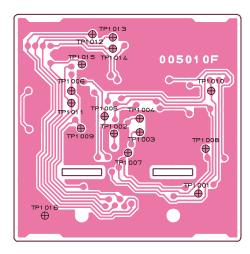


Side A

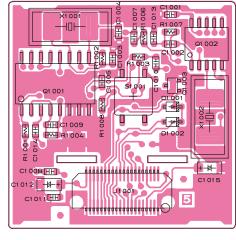
FVP-25 Encryption / DTMF Pager Unit (Option)

Circuit Diagram





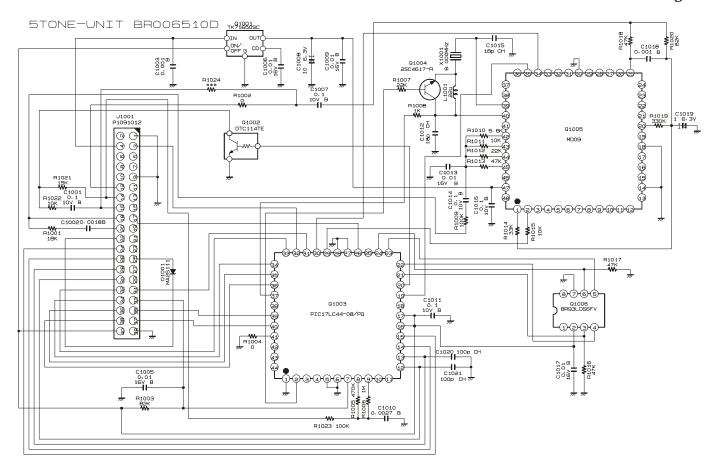




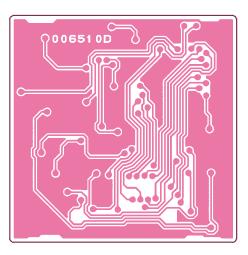
Side A

F5D-14 5-Tone Unit (Option)

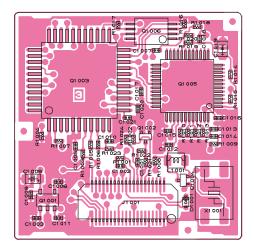
Circuit Diagram



Parts Layout



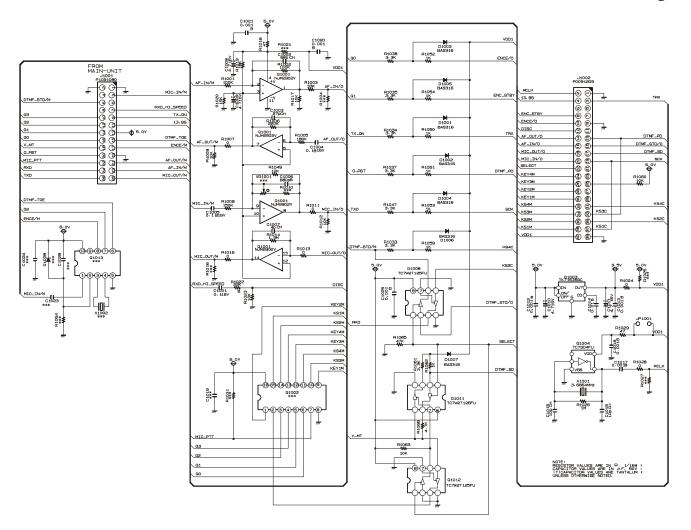
Side B



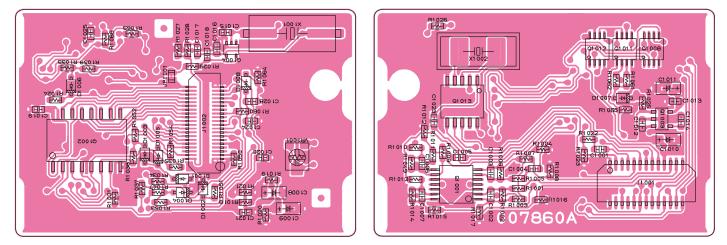
Side A

FIF-7 Connection Unit (Option)

Circuit Diagram



Parts Layout



Side A

Side B



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